Infortrend

SentinelRAID 170

320MB/sec SCSI-to-SCSI RAID Controller

Installation and Hardware

Reference Manual

Version 1.1 (04, 2004)

Printed in Taiwan

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This Edition First Published 2004

Disclaimer

Trademarks

Warnings and Certifications

FCC (applies in the U.S. and Canada)

This device complies with Part 15 of FCC Rules. Operation of this device is subject to the following two conditions: 1) this device may not cause harmful interference, and 2) this device must accept any interference received, including interference that may cause undesired operation.

Warning:

Use only shielded cables to connect I/O devices to this equipment.

You are cautioned that changes or modifications not expressly approved by the party responsible for compliance could void your authority to operate the equipment.

CE   This device is in conformity with the EMC

Table of Contents

Safety Precautions

Precautions and Instructions

- Prior to powering on the controller, ensure that the correct power range is being used.

- Ensure there is a sufficient cooling airflow to maintain the temperature of the controller board. If the controller board overheats it may be permanently damaged.

- Be sure that the rack cabinet into which the controller will be installed provides sufficient ventilation channels and airflow circulation around the controller.

- Handle controller carefully and gently. Avoid touching PCB boards and connector pins.

- To comply with safety, emission, or thermal requirements, none of the covers or replaceable modules should be removed. Make sure that during operation, all covers are securely in place.

- Provide a soft, clean surface to place your controller on before working on it. Servicing on a rough surface may damage the exterior of the chassis.

ESD Precautions

Observe all conventional anti-ESD methods while handling system modules. The use of a grounded wrist strap and an anti-static work pad are recommended. Avoid dust or debris in your work area.

About This Manual

This manual:

- Introduces the SentinelRAID 170 controller.

- Describes all the SentinelRAID 170 active components.

- Provides recommendations and details about the controller hardware installation process.

- Briefly describes how to monitor the controller.

- Describes how to maintain the controller.

This manual does not:

- Describe components that are not user-serviceable.

- Describe the configuration options of firmware, using terminal emulation programs, or the RAIDWatch GUI that came with your subsystem.

Who should read this manual?

This manual assumes that its readers are experienced with computer hardware installation and are familiar with RAID controllers.

Related Documentation

- Generic Operation Manual

- RAIDWatch User's Manual

These two documents can be found in the CD included with your subsystem package.

Conventions

Naming

From this point on and throughout the rest of this manual, the SentinelRAID series is referred to as simply the "controller" and SentinelRAID is frequently abbreviated as "SR."

Warnings

Warnings appear where overlooked details may cause damage to the equipment or result in personal injury. Warnings should be taken seriously. Warnings are easy to recognize. The word "warning" is written as "**WARNING,**" both capitalized and bold and is followed by text in italics. The italicized text is the warning message.

Cautions

Cautionary messages should also be heeded to help you reduce the chance of losing data or damaging the system. Cautions are easy to recognize. The word "caution" is written as "**CAUTION,**" both capitalized and bold and is followed by text in italics. The italicized text is the cautionary message.

Notes

These messages inform the reader of essential but non-critical information. These messages should be read carefully as any directions or instructions contained therein can help you avoid making mistakes. Notes are easy to recognize. The word "note" is written as "**NOTE,**" both capitalized and bold and is followed by text in italics. The italicized text is the cautionary message.

Lists

Bulleted Lists: Bulleted lists are statements of non-sequential facts. They can be read in any order. Each statement is preceded by a round black dot "•."

Numbered Lists: Numbered lists are used to describe sequential steps you should follow in order.

Software and Firmware Updates

Please contact your system vendor or visit Infortrend's FTP site (ftp.infortrend.com.tw) for the latest software or firmware updates. *NOTE* that the firmware version installed on your system should provide the complete functionality listed in the specification sheet/user's manual. We provide special revisions for various application purposes. Therefore, DO NOT upgrade your firmware unless you fully understand what a firmware revision will do.

Problems that occur during the updating process may cause unrecoverable errors and system down time. Always consult technical personnel before proceeding with any firmware upgrade.

Chapter 1
Introduction

1.1. Product Overview

1.1.1 Product Introduction

This hardware manual briefly introduces the SentinelRAID 170 (SR 170) 320MB/second SCSI (SCSI-320) -to-SCSI RAID controller shown in *Figure 1-1*.

Figure 1-1: SentinelRAID SCSI-to-SCSI RAID Controller

The SR 170 controller is designed to meet the high availability, high performance, and extreme fault tolerant demands placed on RAID controllers operating in today's most extreme storage environments. The controller uses RAID technology to endow a host system with high-speed, fault-tolerant disk storage operation. The SR 170 controller is an ideal solution for weaving multiple hard drives into one or more contiguous volumes as well as enhancing storage availability, integrity, and performance.

With high-speed SDRAM modules and firmware in flash memory, a PowerPC® RISC CPU performs all RAID functions on the SR 170 controller, which supports RAID 0, 1 (0+1), 3, 5, 10, 30, 50, or JBOD RAID storage to any host system equipped with a SCSI-320 interface. The controller's operation is completely independent of the host operating system.

Four VHDCI SCSI connectors at the back of the controller board facilitate the connection of the four SCSI-320 I/O channels to external hosts and drives. All the I/O channels can be configured either as host or drive. Other external interfaces include two COM ports and an RJ-45 Ethernet connector. The COM 1 port is used for serial communications and

connects to a PC hyper-terminal that is used to configure the controller and the subsystem in which it is embedded. The LAN port enables the controller to connect to the web-based RAIDWatch™ management program that enables you to manage your controller from anywhere in the world. Two power supply unit (PSU) connectors ensure the controller can be connected to dual-redundant power supplies.

An LCD panel is conveniently attached to the front of the controller box and can also be used for controller configuration and troubleshooting. The LCD panel has three navigation buttons and three status-indicating LEDs.

1.1.2 Enclosure

The SR controller enclosure is divided into a front and rear section.

1.1.2.1 Controller Box

The controller box contains both the controller board and the separately purchased, independently installed DIMM modules. Two optional items, the daughter board and the battery backup unit (BBU) module, are also installed in the controller box. To access the controller board it is necessary to remove the top cover of the controller box. The top cover is secured to the controller box with four retention screws, two on each side.

WARNING:
Although the controller board can be accessed by removing the enclosure top cover, it should always be remembered that the controller board is a very sensitive component and can be easily damaged. When accessing the controller board it is imperative that all safety precautions stipulated in Chapter 2 are strictly adhered to.

1.1.2.2 Front Side

The LCD panel located on the front panel is used to configure and manage the controller and storage devices to which it is attached. It is connected to the controller board with a ribbon cable.

1.1.2.3 Rear Side

The rear side of the SR controller chassis provides access to the SCSI-320 connectors, power cord sockets, RS-232C serial port, I^2C connector and battery connector.

1.1.2.4 Mounting Holes

The controller can be installed into an industrial standard 5.25-inch half-height canister. To secure the controller within an enclosure chassis, screws must be inserted through the enclosure's mounting rails, into the four mounting holes on the sides of the controller.
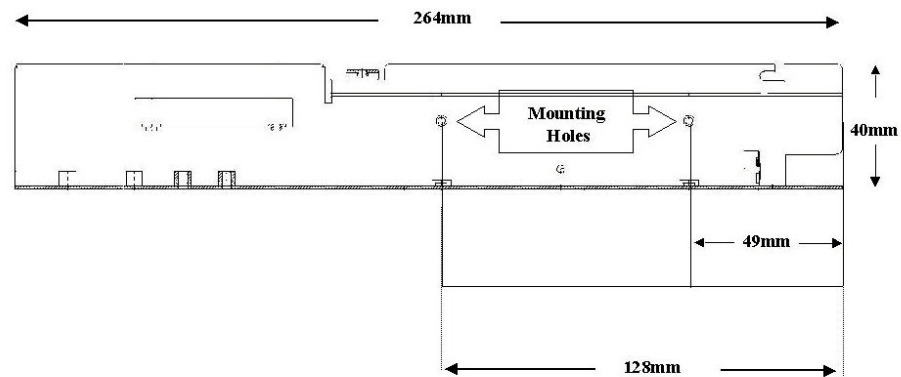
Figure 1-2: SR Enclosure Canister Mounting Holes

1.2. SR Components

1.2.1 LCD Panel
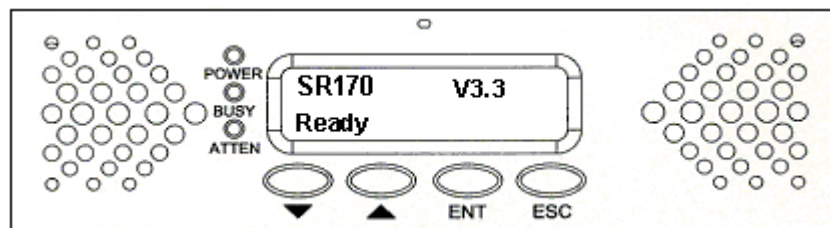
Figure 1-3: LCD Panel

The LCD panel shown in *Figure* 1-3 consists of a 16x2 character LCD screen with two navigation buttons (labeled as ▼ ▲ in *Figure* 1-3), three status-indicating LEDs (**POWER**, **BUSY** and **ATTEN**), an enter button (labeled **ENT**) and an escape button (labeled **ESC**). The LCD front panel provides full access to all RAID configurations and monitoring. After powering up the controller, the initial screen will show the controller model name. A different name may be assigned for the system or different arrays. This will enable easier identification in a topology with numerous arrays.

1.2.2 Controller Board

WARNING:

The controller board is a very sensitive component that can be easily damaged. When working with the controller board make sure all safety precautions are strictly adhered to. Failure to adhere to these safety instructions can result in severe damage to the controller board.

The heart of the SR 170 controller is the SCSI-to-SCSI controller board (see *Figure1-4*). The controller board has four SCSI-320 I/O channels (CH0, CH1, CH2 and CH3). Two

upgrade sockets allow for the installation of a daughter board that facilitates the addition of four SCSI-320 I/O channels. All I/O channels (both base channels and expansion channels) can be configured as either host or drive channels.

The controller board also comes with a 68-pin SDRAM DIMM socket that facilitates the installation of a 64MB to 1GB SDRAM DIMM module. A variety of other onboard connectors and jumpers facilitate the connection of a variety of accessory components like battery module charger boards. These jumpers and connectors are listed in *Table 1-1*.

Connector Type	Label	Description
Daughter Board Connectors	**JP1** and **JP13**	These two connectors are used if an expansion daughter board is being installed on the controller module.
Battery Charger Board Connector	**JP6** and **JP11**	These connectors are used to mount the optional battery charger board onto the controller board.
LED Connectors	**JP2, JP3, and JP4**	Partner Failed! (JP2), Not Ready (JP3) and Ready (JP4)
Not Mask Interrupted (NMI)	**JP5**	Only used by Infortrend for debugging.
Reset	**JP7**	Used to reset the controller
LCD Type Selection	**JP10**	Only used by Infortrend for testing.
LCD Connector	**JP14**	This jumper is used to connect the LCD screen to the controller board with a ribbon cable.
Restore Firmware Default	**JP19**	This jumper is used to restore the firmware default settings.
Front Panel Fan Status Detect	**JP22**	Helps to determine the operational status of the fans at the back of the front panel.

Table 1-1: Controller Jumpers and Connectors

The jumpers listed in *Table 1-1* above are all located at the front of the controller board. (See *Figure1-4*)
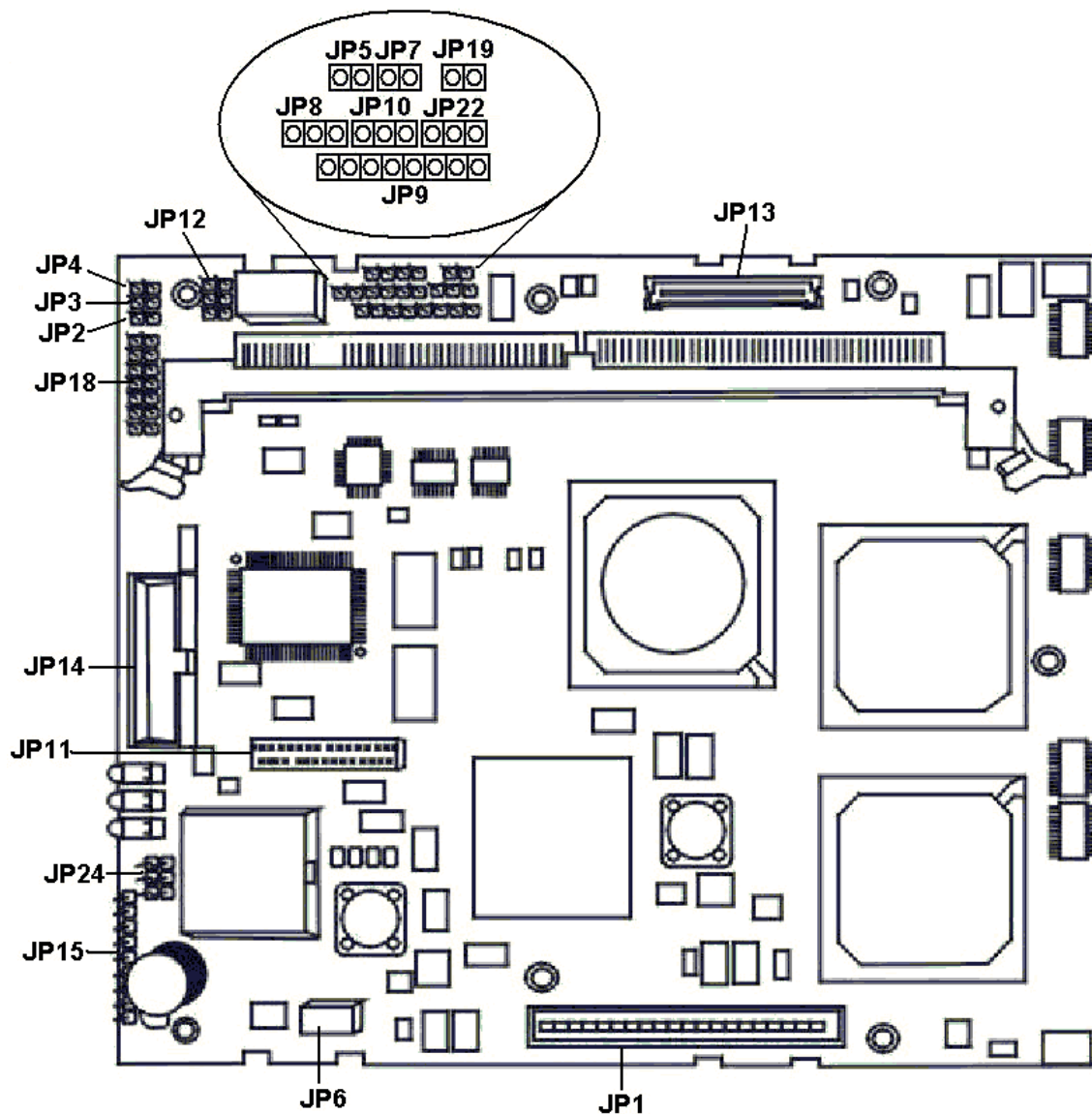
Figure1-4: Controller Board (Front)

1.2.3 Interfaces

The external interfaces (see ***Figure1-5***) are all located at the back of the controller board and are easily accessible at the rear of the controller enclosure. These interfaces include the SCSI-320 I/O channel connectors, power cord sockets, RS-232C serial port connector, I^2C connector and battery connector. The backplane interfaces are fully described in ***Table 1-2***. Their locations are shown in ***Figure1-5***.

Connector Type	Label	Description
SCSI-320 Connectors	**CH0, CH1, CH2** and **CH3**	68-pin VHDCI connectors that facilitate the connection of the SCSI-320 I/O channels to external devices.
I²C Connector	**J3**	I²C supports the monitoring of remote enclosure devices.
Battery Connector	**J1**	Allows an optional battery backup unit (BBU) to be connected to the system.
COM1 and COM2 Connector	**JP16** and **JP17**	These connectors are used for serial port communications. One COM port (COM1) can be used for terminal emulation.
SCSI Terminators	**JP20**	This 8-pin jumper is used to terminate the different I/O channels.
RJ-45 Ethernet Connector	**JP23**	This connector provides users with access to LAN and web-based management of the controller.

Table 1-2: Controller Board Interfaces
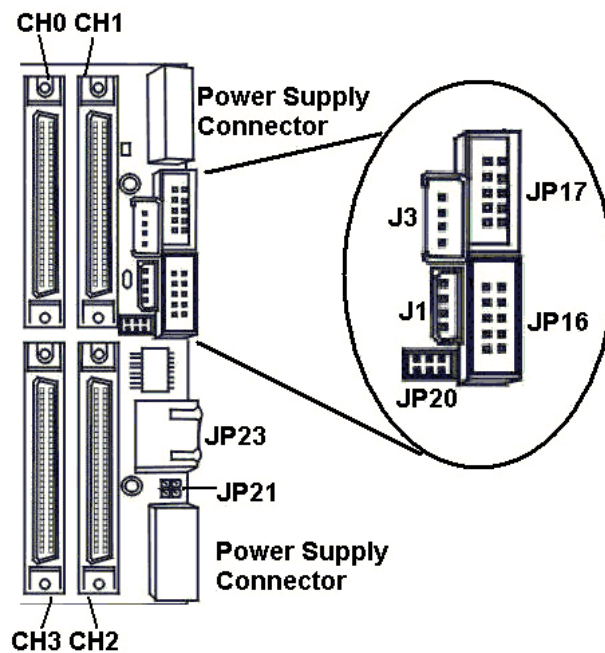
Figure1-5: Controller Board (Rear)

1.3. SR Accessory Items

The following items are not installed on the controller but come in the accessory box and can be used with the SR controller.

1.3.1 Serial Cable

The IFT-9512 RS-232C serial cable allows the serial RS-232C serial communications connector at the rear of the board (**J2**) to be connected to a PC hyper-terminal, which enables a RAID array manager to easily manage and configure the storage array to which the controller is connected.

1.3.2 Null Modem

The null model is a signal converter; please refer to *Appendix D* for more details.

1.3.3 Ethernet Cable

The receptacle side is shaped like a DB-9 connector and can be attached to the back panel of the enclosure using the mounting positions of a serial port header to connect to the outside of the enclosure.

1.3.4 Bezel Key

The IFT-9531 is used to remove the LCD front panel from the controller canister. The only time the LCD front panel needs to be removed is when the controller board needs to be accessed.

1.4. Separately Purchased Accessory Items

The following items are required to run the SR controller. You must purchase them separately and install them yourself.

1.4.1 DIMM Modules

The SR controllers support PC-133 SDRAM DIMM modules with ECC support and capacities between 128MB and 1GB. DIMM modules must be separately purchased and installed by the end user. The SDRAM DIMM module socket is located on the controller board and can only be accessed by removing the top cover of the controller enclosure.

NOTE:

Although the hardware is able to support a minimum SDRAM DIMM module size of 128MB, it is recommended that DIMM modules with a minimum capacity of 256MB are used.

1.4.2 SCSI Cables

SCSI cables are required to connect the 68-pin connectors on the backplane to the SCSI-320 drives and SCSI-320 hosts. When purchasing SCSI-320 cables, select cables of the highest quality that are produced by a reputable manufacturer. To ensure optimum SR controller performance it is necessary to use proper, high quality, durable SCSI-320 cables. Failure to do so will result in downgraded performance. Please contact the SR controller vendor for a list of compatible cables.

1.4.3 Power Connector

Two four-pin power cord connectors are located on the right and left sides at the back of the controller board. These connectors facilitate the power supply connection.

1.4.4 I²C Signal Compatible Cables

These cables are required for enclosure device monitoring.

1.5. Optional Items

1.5.1 Battery Backup Unit (BBU)

The controller operates using cache memory. However, if the controller operates with write-back caching and a power failure occurs, the cache memory may contain buffered data that has not been made permanent on hard disks.

The buffered data is not retrievable when power returns unless backup power has been provided. The combination of the optional, separately purchased IFT-9070D battery charger board (*Figure 1-7*) and IFT-9010D BBU module (*Figure 1-6)* allows two battery packs to be daisy-chained for longer backup time and each BBU can sustain the cache memory for 72 hours. The IFT-9519D extension cable can be used to cascade multiple cell packs or to extend the connection between the controller and cell pack.

Each battery in the cell pack has a storage capacity of 3A/H when fully charged, and three cells are used for a total of 3.6V source. The charger circuit on the IFT-9070D provides a 160mA charge until either a ninety-minute time limit has been surpassed or the temperature limit of 65ºC is reached. After fast charging, the charger will shift to a trickle stage until the charge is full.
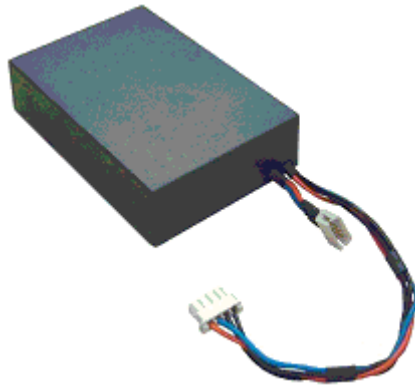
Figure 1-6: IFT-9010D BBU Module
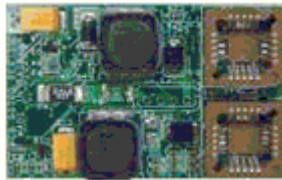
Figure 1-7: IFT-9070D Battery Charger Board

1.5.2 Daughter Board Expansion

The installation of an optional daughter board makes four additional SCSI-320 I/O channels available.

1.6. Environmental Requirements

When installing and running an SR controller, the following environmental considerations must be taken into account.

1.6.1 Power Supply Requirements

Two power cord connectors facilitate the connection of two redundant power supply units (PSUs). If redundant PSUs are used and one PSU fails, the second PSU continues to supply power to the SR controller. The SR power requirements are listed below:

Input Voltage   +5VDC, +12VDC
Power Consumption (5V)

- *Full Loading:*   5.5A
- *Idle:*   3.5A
- *Power-up:*   4A

When purchasing a PSU, the power requirements listed above must be taken into consideration. Please contact the SR controller vendor for a list of compatible PSUs.

1.6.2 Cooling Requirements

Proper SR controller cooling is required to ensure that the temperature of the critical controller board components does not exceed the operational temperature range. The main components on the controller board that can overheat are:

ASIC 133
CPU
SCSI Chip(s)

The temperature of these items cannot exceed 80°C. Of the three items listed, the CPU will heat up the most. To pre-empt overheating of the CPU, a heat sink has been mounted on top of the CPU. The heat sink is separated from the CPU with thermal grease.

Prior to installing and powering on the SR controller, it is imperative that you ensure that there is sufficient cooling of the controller.

1.7. SR Controller Monitoring

The SR controller comes with a number of different monitoring methods that enable you to constantly be updated on the status of the controller and the storage array to which it is connected.

1.7.1 I²C Bus

The I^2C bus allows for the status monitoring of a number of different devices like power supplies and cooling fans.

1.7.2 LED Indicators

The LCD front panel has three LED status indicators that show that the power is on, when there is activity on the I/O channels, and when an error message appears on the LCD screen itself.

1.7.3   Firmware (FW) and RAIDWatch GUI

Firmware: The firmware is pre-installed software used to configure the controller. The FW can be accessed through either the front panel LCD module or a terminal emulation program that is installed on an external computer connected to the host.

RAIDWatch: RAIDWatch is a premier web-based graphics user interface (GUI) that can be installed on a remote computer and accessed via the web.

1.7.4 Audible Alarms

The SR controllers come with audible alarms that will be triggered when certain active components fail or when certain thresholds are exceeded. If you hear an audible alarm being emitted from the SR controller it is imperative that you determine and rectify the problem immediately.

WARNING:
Failing to respond when an audible alarm is heard can lead to permanent damage of the SR controller. If an audible alarm is heard, rectify the problem as soon as possible.

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Chapter 2
Installation

2.1. Installation Overview

CAUTION:
Please note that the installation instructions described in this manual should be carefully followed. Failure do to so may result in damage to the system.

2.2. Installation Prerequisites

1. ***Static- free installation environment:*** The SR controller must be installed in a static free environment to minimize the possibility of electrostatic discharge (ESD) damage. (See ***Section 2.3.2***).

2. ***Component check:*** Before the SR controller is installed, you should confirm that you have received all the components on the Unpacking List during the unpacking process. (See ***Section 2.5***)

3. ***Memory modules:*** Modules must be separately purchased and installed. (See ***Section 2.7***)

4. ***Hard drives:*** SCSI-320 hard drives must be purchased separately prior to installation of the SR controller.

5. ***Cabling:*** All the SCSI cables that are used to connect the SR controller to the host and drives must be purchased separately. (See ***Section 4.2.1***)

2.3. Safety Precautions

2.3.1 General Considerations

♦ ***Power source:*** Make sure the power source is within the correct power range prior to powering on.

♦ ***Earth***: Always make sure the controller has a safe electrical earth connection via the power cords or chassis ground on the rack/cabinet.

♦ ***Ventilation:*** Be sure that the rack cabinet provides sufficient ventilation channels and airflow circulation throughout the enclosure in which the SR controller is installed.

♦ *Working surface:* Provide a soft, clean surface on which to place your controller before working on it. Servicing on a rough surface may damage or scratch the enclosure.

2.3.2 Static-free Installation

Static electricity can damage the electronic components of the system. Most of the controllers that are returned for repair are the result of improper installation and ESD damage. To prevent ESD damage, follow these precautions before touching or handling any of the components:

♦ When installing the SR 170, you should wear an anti-static wrist band or touch a grounded metal surface to discharge any static electricity form your body.

♦ Avoid carpets, plastic, vinyl, or styrofoam in the work area.

♦ Handle any components by holding its edges or metal frame. Avoid touching PCB boards or connector pins.

2.4. Hardware Installation Preparation

2.4.1 Tools or Equipment Needed for Installing the Subsystem

The only tools necessary are #2 cross-head Phillips and 3/16-inch slotted screwdrivers.

2.4.2 Planning Before Installation

♦ *Module locations:* Make sure you are aware of the related positions of each plug-in module and interface.

♦ *I/O path configurations:* The SR controllers have four SCSI-320 I/O channels interfaced through four SCSI ports. The installation of an optional daughter board increases the available SCSI-320 I/O channels by four. All I/O channels can be configured as either host or drive channels.

♦ *I/O port cabling:* All series models are equipped with 0.8mm VHDCI SCSI connectors. Please contact Infortrend technical support for an updated list of host adapters that have been tested and proved compatible with the SR controller series.

♦ *Power supplies:* Two power cord connectors ensure that redundant power supplies can be connected to the SR controller so that in the event that one power supply fails, the second power supply will continue to supply sufficient power to run the SR controller.

2.4.3   General Installation Procedure

If the steps listed below are followed, the installation of the SR controller should be smooth and efficient. Detailed, illustrated instructions for each step are given in the following sections.

CAUTION:

To ensure that the system is correctly installed, please follow the steps outlined below. If these steps are not followed, the hardware may accidentally be installed incorrectly.

Step 1.   *Unpack*. Unpack the SR controller and make sure that all the components that are meant to come with the subsystem have indeed arrived. (See *Section 2.5*)

Step 2.   *Install the DIMM module*. The SR controller does not come with pre-installed DIMM modules. Separately purchased DIMM modules need to be installed. (See *Section 2.7*)

Step 3.   *Install the optional BBU*. Install the optional BBU prior to operating the SR controller. (See *Section Error! Reference source not found.*)

Step 4.   *Install the optional daughter board*. If you require more than two SCSI-320 I/O channels, the optional daughter board with the appropriate expansion channels must be installed. (See *Section 2.9*)

Step 5.   *Rack/Cabinet installation*. Install the SR controller into an appropriate cabinet or rack.

Step 6.   *Connect the host*. Connect the user-configured host channels to the host computer.

Step 7.   *Connect the drives*. Connect the user-configured drive channels to the hard drives.

2.5.   Unpacking the Controller

NOTE:
*A detailed packing list is located in **Appendix D** of this manual.*

When unpacking the controller, please ensure that all of the items listed on the unpacking list that came with the controller are present. If any of the listed items are missing, please contact the controller vendor immediately. A complete unpacking list is given in *Appendix D*.

2.6. Accessing the Controller Board

2.6.1 Overview

The controller board is located in the controller box and should only be removed from the controller box if the controller board fails. However, it is necessary to access the controller board in order to install the DIMM module, optional BBU module and the optional daughter board. To access the controller board, remove the top cover of the controller box. Replace the cover after the different components have been correctly installed.

2.6.2 Removing and Replacing the Chassis Top Cover

♦ *Removing the top cover:* The chassis top cover is secured to the chassis with four retention screws (two on each side). To remove the top cover, remove these four retention screws (see *Figure 2-1*). Once they have been removed, gently lift the top cover up to expose the controller board.
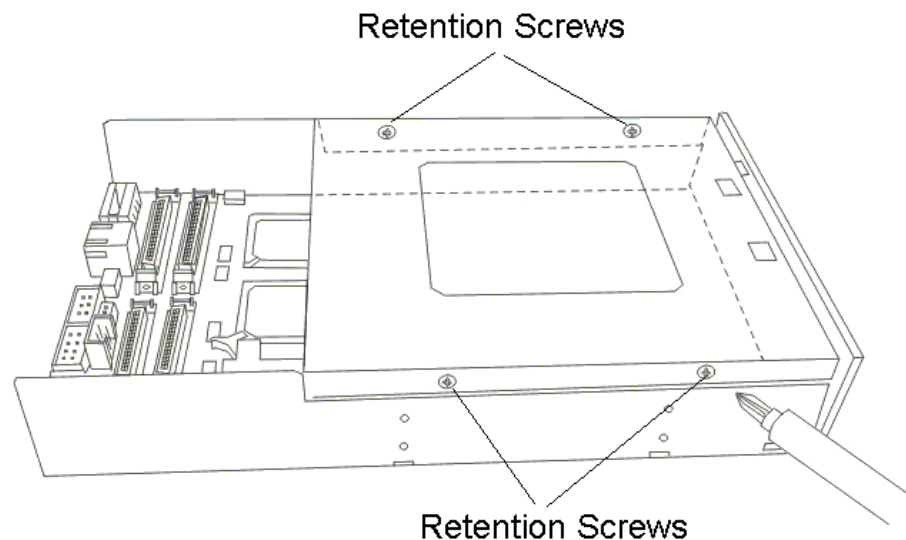
Figure 2-1: Remove the top cover

♦ *Replacing the top cover*: After the controller board components have been installed, the chassis top cover must be replaced. To do this, make sure the front panel LCD screen is properly positioned. Next, ensure the top cover is correctly oriented. Notice that the two rectangular holes in the top cover are located at the front and must be installed in this way. Once correctly oriented, gently place the top cover on the chassis and re-insert the four previously removed retention screws (two on each side).

2.7. Memory Module Installation

The SR controller comes without a DIMM memory module. It is therefore necessary for a separately purchased DIMM module to be installed.

2.7.1 Selecting the DIMMs

When purchasing the DIMM modules, the following factors must be considered:

♦ *Supported SDRAM DIMM modules:* The SR controllers support SDRAM DIMMs with memory capacities between 128MB and 1GB with ECC support.

♦ *Installation considerations:* When installing the SDRAM DIMM module, it is necessary to handle the controller board. The controller board is susceptible to damage and must therefore be handled with extreme care. ALL anti-static precautions specified in *Section 2.3.2* must be strictly adhered to.

♦ *Secure installation:* When installing the DIMM module, make sure that the DIMM module is firmly in place prior to installing the controller. If the DIMM module is not firmly in place, the controller will not be able to run and will need to be removed and the DIMM module correctly installed.

♦ *Purchasing considerations:* When purchasing an SDRAM DIMM to install on the controller board, contact the SR controller vendor.

2.7.2 DIMM Module Installation Procedure

To install a DIMM module into the SR controller, please follow these steps:

Step 1. *Remove the chassis top cover*. Before installing the DIMM module, remove the chassis top cover. For further instructions on how to remove the top cover, please refer to *Section 2.6.2*.

Step 2. *Insert the DIMM module*. Once the chassis top cover has been removed, install the DIMM module. To do this, first push the white clips on either side of the DIMM module in an outward direction. Next, align the DIMM module with the DIMM slot. Then, gently push the DIMM module into the slot. The white clips should automatically close and secure the DIMM module into the DIMM slot. (See *Figure 2-2*)
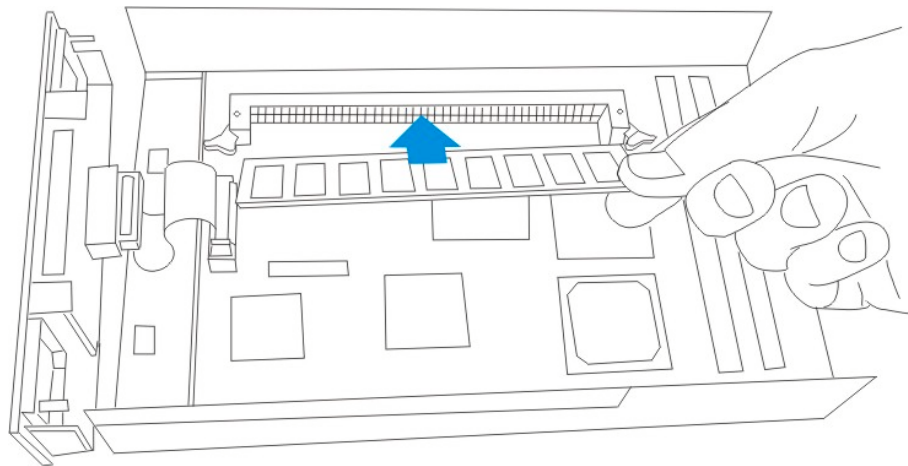
Figure 2-2: Install the DIMM Module

> **Step 3.** *Replace the chassis top cover*. Once the DIMM module has been installed and if no other items (e.g., BBU module or expansion daughter board) are being installed on the controller board, reinstalled the chassis top cover. For further instructions on how to reinstall the chassis top cover, please refer to *Section 2.6.2*.

2.8. Battery Backup Unit (BBU) Installation

2.8.1 About the First BBU Installation

♦ It is possible that the linking cable connecting the IFT-9070D charger board and IFT-9010D cell pack has contact with the components on the surface of the controller main board. While routing this cable from one side to the other, please note that some chip surfaces must be avoided. The surface temperature on chips such as SCSI processors may reach high temperatures and damage the plastic shielding on a linking cable.

♦ A battery has a tendency to "remember" its capacity. In order to make full use of the capacity of your battery cells, allow the battery cell pack to become fully charged when installed for the first time. It will take 24 hours for the battery to become completely charged for the first time. Once the battery module is installed and the controller is powered on, the battery will automatically start charging. Do not power down the controller during the first 24 hours after the BBU has been installed. If the controller power is turned off and there is unwritten data in the cache memory, the battery will start discharging.

♦ Inspect the BBU regularly and replace it every **TWO** years; use an official battery pack replacement and only use them with specified RAID controllers.

♦ When replacing the controller's DIMM module, be sure to disconnect the BBU.

♦ During normal use, an empty cell pack takes about 20 hours to recharge.

♦ Disconnect the BBU if there is a long storage period before deployment. Extreme storage conditions should be avoided (i.e., temperatures <-20ºC or >65ºC, relative humidity >65%±10%).

2.8.2 BBU Installation Procedure

Step 1. *Remove the chassis top cover*. Before installing the BBU module, remove the chassis top cover. For further instructions on how to remove the top cover, please refer to *Section 2.6.2*.

Step 2. *Remove the battery connector cap*. The connector that connects the BBU is covered with a cap that must be removed. Remove this cap by gently pulling it up. Put the cap in a safe place in case it needs to be replaced at a future time. (See *Figure 2-3*)

WARNING
The battery cap must be put in a safe place. If the BBU module is removed from the controller board, the controller will not operate unless the BBU cap is reinstalled on the board-to-board connector from which it was removed.
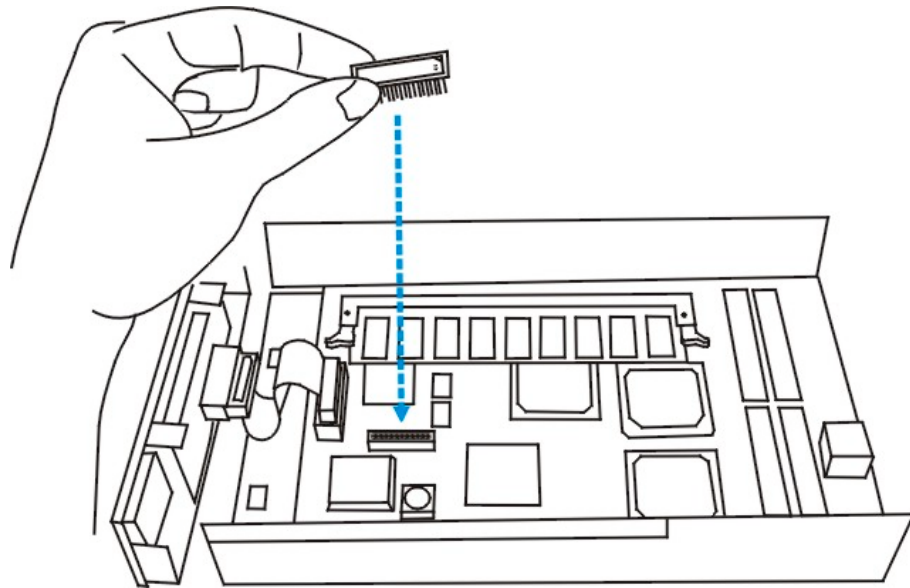
Figure 2-3: Remove the Battery Connector Cap

Step 3. *Install the battery charger board.* The battery charger board comes with two board-to-board connectors. Align the appropriate connectors with jumper 7 (JP7) and jumper 2 (JP2) on the controller board. Once these connectors are aligned with the jumpers, gently insert them into the jumpers. (See *Figure 2-4*)
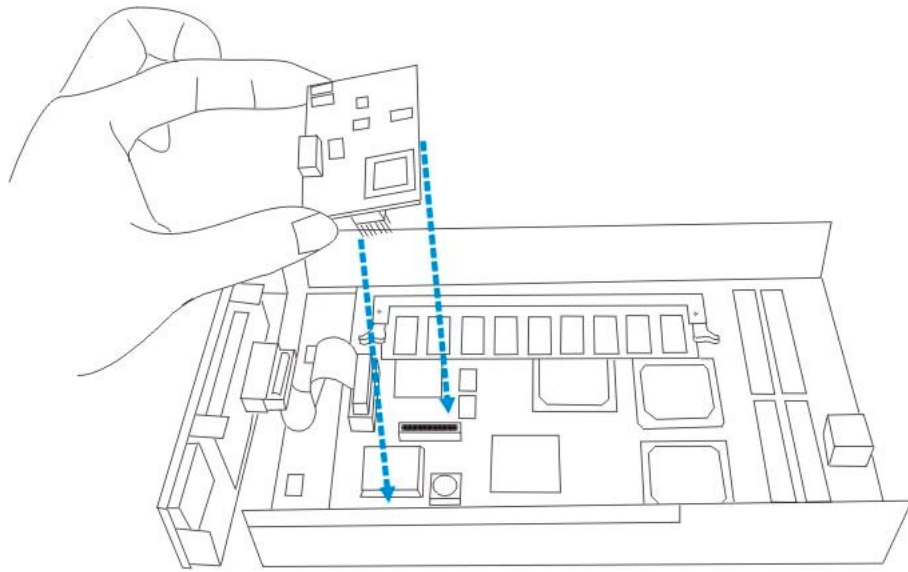
Figure 2-4: Install the Battery Charger Board

Step 4. *Connect the BBU cable*. The BBU cable can be connected to a white, 4-pin header on either the BBU charger board (see *Figure 2-5*) or at the back of the controller board (labeled J4) (see *Figure 2-6*). If the BBU cable is going to be connected to the charger board, the connections should be made now. If the BBU is going to be connected to the connector at the back of the board, the connection can be made now or after the chassis top cover has been replaced.
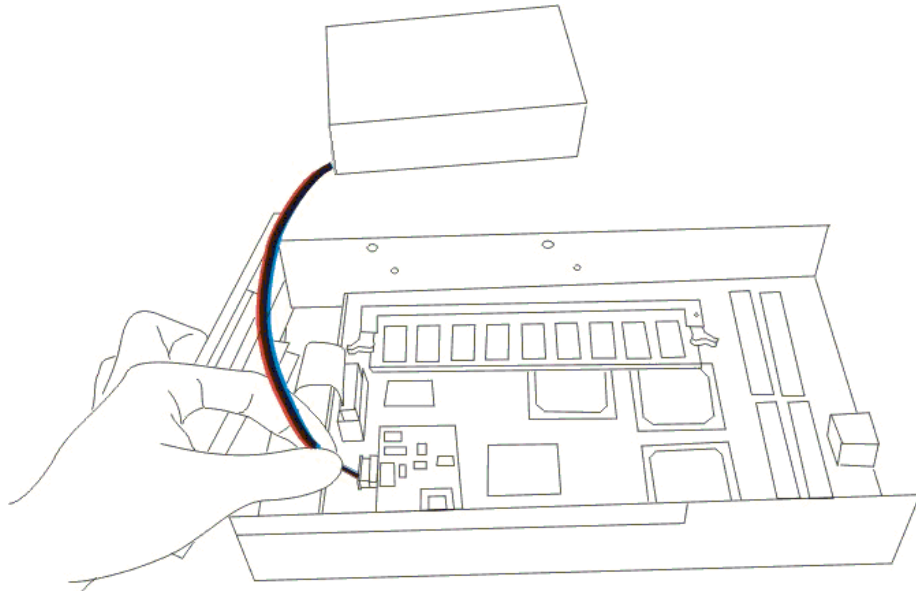
Figure 2-5: Connect the BBU to the BBU Charger Board
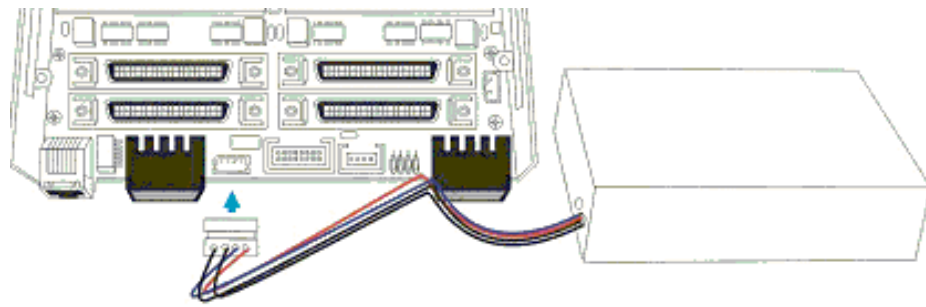
Figure 2-6: Connect the BBU to the Connector at the Back of the Controller Board

Step 5.   *Replace the chassis top cover*. Once the battery charger board has been installed on the controller board, the chassis top cover must be reinstalled. For further instructions on how to reinstall the chassis top cover, please refer to *Section 2.6.2*.

Step 6.   *Attach the BBU to the enclosure*. Integrators can use the four, pre-drilled mounting holes on the BBU to attach the BBU to a custom designed enclosure.

2.9. Daughter Board Installation

2.9.1 About Daughter Board Installation

♦   The optional, separately purchased daughter board allows you to add an additional four SCSI-320 I/O channels to the SR controller.

♦   The daughter board, like the controller board, is a very sensitive component and must be treated carefully. All anti-static precautions must be strictly adhered to and all the controller safety precautions observed.

2.9.2 Daughter Board Installation Procedure

Step 1.   *Remove the chassis top cover*. Before installing the daughter board, remove the chassis top cover. For further instructions on how to remove the top cover, please refer to *Section 2.6.2*.

Step 2.   *Install the daughter board*. The daughter board is mounted on four pre-installed spacers located in the middle of the controller board, just in front of the SCSI connectors. Place the daughter board onto the docking connectors so that the retention screw holes on the daughter board are clearly aligned with the spacers.
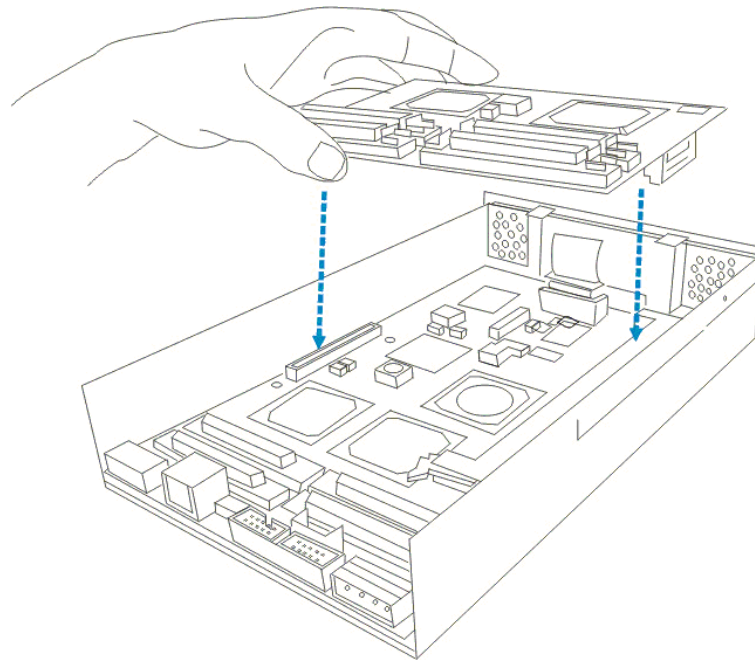
Figure 2-7: Install the Daughter Board

Step 3. *Insert the retention screws.* Once the daughter board has been mounted on the board-to-board connectors, insert the retention screws that came with the daughter board. (See *Figure 2-8*)
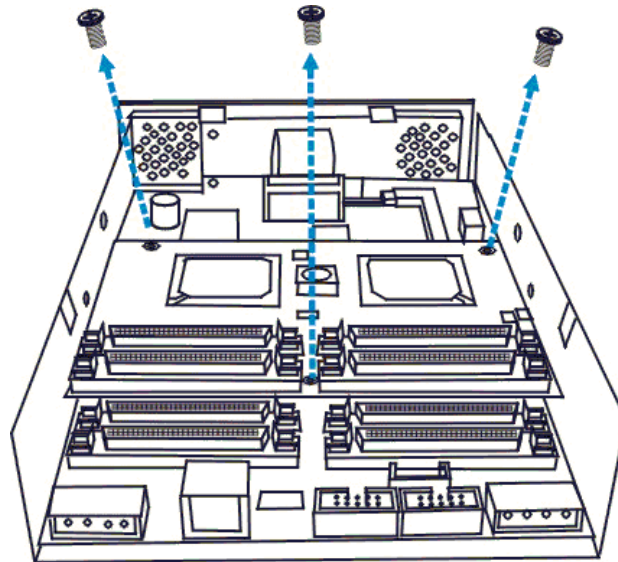
Figure 2-8: Install the Daughter Board Retention Screws

Step 4. *Replace the chassis top cover*. Once the daughter board has been installed on the controller board, reinstall the chassis top cover. For further instructions on how to reinstall the chassis top cover, please refer to *Section 2.6.2*.

Chapter 3
Controller Monitoring

3.1. Controller Monitoring Overview

The SR controller is equipped with a variety of self-monitoring features that help keep controller managers informed of the controller's operational status. These monitoring features provide vital feedback that helps you maintain the operational integrity of your controller. Prompt response to warnings and failure notifications will improve the overall operation and help ensure the longevity of the SR controller.

Self-monitoring features include:

♦ *Management firmware (FW)*: The SR controller comes with pre-installed FW (version 3.31 or above). Device status information can be obtained from the FW. This FW can be accessed using either the LCD panel or a PC hyper-terminal. The FW is fully described in the *Generic User's Manual* that came with the subsystem. Please refer to this manual for further details.

♦ *RAIDWatch*: RAIDWatch is a fully integrated Java-based Graphics User Interface (GUI) that came with the controller and can be used to monitor the controller remotely. You can use the powerful *Notification Process Center* (NPC) sub-module to keep you informed over a variety of communication devices such as fax, pager, e-mail, etc. The installation and operation of RAIDWatch is fully described in the *RAIDWatch User's Manual*. Please refer to this manual for further details.

♦ *LEDs*: Device status indicating LEDs are placed on the front panel of the SR controller. These LEDs inform you of the integrity and status of different controller items. You should become familiar with these LEDs and be aware of their functions.

♦ *Audible alarm*: An audible alarm is present on the controller board and will be triggered if any of a number of threatening events occur. These events usually jeopardize the functional and operational integrity of the controller board and must be heeded at all times. Events such as a breach of the temperature threshold will trigger the alarm and if an onsite controller manager is present, the manager should use either the LCD panel or the PC hyper-terminal to determine the cause of the alarm and take the appropriate corrective measures.

♦ *I^2C*: The I^2C bus monitors the operational integrity of a variety of components.

Controller monitoring is a necessary part of controller management. If failure events or other disruptive events are detected and reported, controller managers must take the appropriate action to rectify the problem. Failure to act in a properly specified manner to a system event (like overheating) can cause severe and permanent damage to the controller.

3.2. Status-indicating LEDs

The front panel LCD panel comes with three status-indicating LEDs. The LEDs on the front panel are marked, from top to bottom, **PWR**, **BUSY** and **ATTEN,** as shown in *Figure 3-1* below. The definitions of these LEDs are shown in *Table 3-1*.
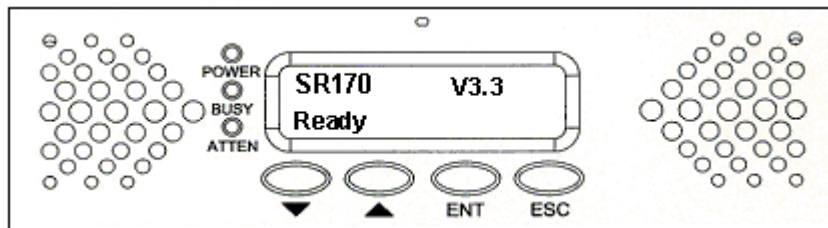
Figure 3-1: LCD Panel LEDs

LED Name	Color	Status
PWR	**Blue**	**ON** indicates that power is being supplied to the controller. **OFF** indicates that no power is being supplied to the controller.
BUSY	**White**	**ON** indicates that there is activity on the host/drive channels. **OFF** indicates that there is no activity on the host/drive channels.
ATTEN	**Red**	**ON** indicates that a component failure/status event has occurred. **OFF** indicates that the controller and all its components are operating correctly.

Table 3-1: LCD Panel LED Definitions

3.3. Audible Alarm

Different controller environmental and operational parameters (i.e., temperature, etc.) have been assigned a range of values within which they can fluctuate. If either the upper or lower thresholds are exceeded, an audible alarm will automatically be triggered. The alarm will also be triggered when an active component of the SR 170 controller fails. If the SR 170 controller manager is onsite and is alerted by the alarm, the manager needs to read the message on the LCD screen or on the PC terminal to determine what has triggered the alarm. After determining what has occurred, the SR 170 controller manager must take appropriate actions to rectify the problem.

WARNING:
Whenever an alarm is triggered, you must determine the problem. If the audible alarm is ignored or not taken seriously and the problem is not rectified, permanent damage to the controller can result.

3.3.1 Default Threshold Values

Table 3-2 shows the default threshold values for the SR controller. If any of these values are surpassed the alarm will sound:

Parameter	*Upper Threshold*	*Lower Threshold*
+3.3V	+3.6V	+2.9V
+5V	+5.5V	+4.5V
+12V	+13.2V	+10.8V
CPU Temperature	90ºC	0ºC
Board Temperature	90ºC	0ºC

Table 3-2: Default Threshold Values

The thresholds in *Table 3-2* are the default threshold values and can be changed. For instructions on how to change these values, please refer to the ***Generic Operation Manual*** that came with your system.

3.4. I^{2}C Port (Enclosure Monitoring)

The I^{2}C interface is designed for Infortrend Simple Enclosure Management Service (ISEMS). FW supports monitoring of remote enclosure devices (power, fan rotation speed, temperature, etc.) through SAF-TE, S.E.S, or I^{2}C interface. Via the I^{2}C interface, the controller collects signals from remote sensors and notifies the system administrator if the signals exceed any critical thresholds.

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Chapter 4
Controller Connections and Operation

4.1. SentinelRAID Connection

4.1.1 I/O Channel Configuration

All of the I/O channels can be configured as either host channels or drive channels. Note that at least one I/O channel on the SR 170 controller must be configured as a host channel and the other channels can all be configured as drive channels.

4.1.2 SCSI Cables

Separately purchased SCSI-320 compatible cables, not longer than 12 meters, must be used for host and drive connection. Purchase SCSI-320 cables of the highest quality produced by a reputable manufacture. It is necessary to use proper, high quality, durable SCSI-320 cables in order to ensure optimum SR controller performance. Failure to do so will result in downgraded performance.

SCSI cables that are used to connect the SR 170 controller to external SCSI-320 devices should be in compliance with the specifications shown in *Table 4-1*.

Electrical	
Impedance	120ΩK10%
Capacitance	15.9 pf / ft @ 1MHz
Propagation Delay	1.59ns / ft nom
DC Resistance	95Ω / 1000 ft @ 20°C
Delay Skew	0.035ns / ft (max.)

Table 4-1: SCSI-320 Cable Electrical Specifications

4.1.3 Host Connection

I/O channels configured as host channels can be connected to a SCSI-320 host computer using an industry-standard SCSI-320 cable.

4.1.4 Drive Connection

Each drive channel can be connected to up to fifteen SCSI-320 hard drives. The maximum number of drives that can be connected to each controller is shown in ***Table 4-2*** below:

Model	Host Channels	Drive Channels	Maximum Number of Drives
SR 170	1	3	45
SR 170 + IFT-9284U4	1	7	105

Table 4-2: Maximum Number of Drives

4.1.5 SCSI Termination

It is important that both the host and drive SCSI cables are properly terminated. If these cables are not properly terminated, then signals being transmitted along the SCSI bus may become corrupted. When multiple drives are connected together (as shown in the topologies below) the SCSI terminators on the individual drives must be disabled.

4.1.6 Unique IDs

SCSI devices connected on the same channel have their own unique ID number. This number allows these individual devices to be recognized by the controller when executing I/O commands from the host computer.

4.2. SR 170 Topologies

4.2.1 Single Host Computer

Connection to a single host is shown in ***Figure 4-1***. The single host computer manages all of the logical drives (LDs). In the topology shown in ***Figure 4-1*** the channels are configured as shown in ***Table 4-3***.

Channel	Configured as…
CH0	Host Channel
CH1	Drive Channel
CH2	Drive Channel
CH3	Drive Channel

Table 4-3: SR 170 Single Host Channel Configurations
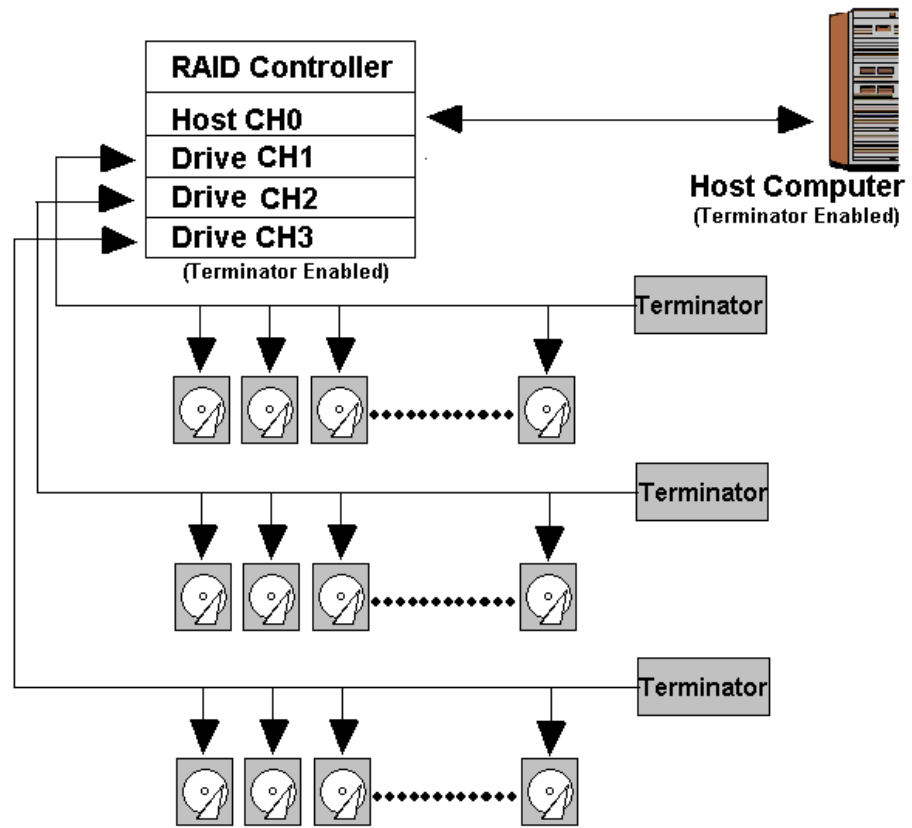
Figure 4-1: Single Host Connection

4.2.2 Dual Host Connection

In *Figure 4-2* two channels (CH0 and CH1) are configured as host channels and two channels (CH2 and CH3) are configured as drive channels. The firmware (FW) can be used to create LDs. These LDs must in turn be mapped to the host channels.
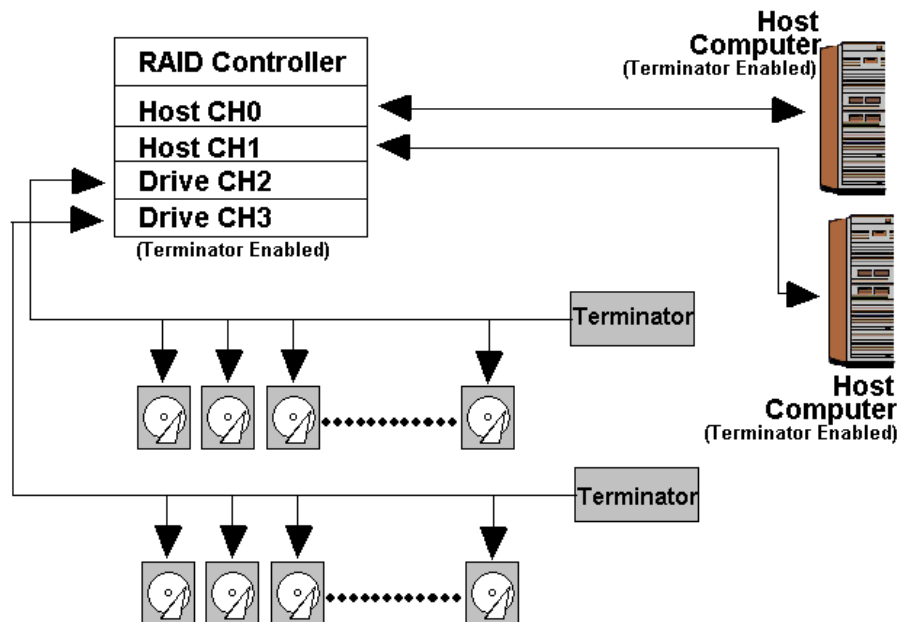
Figure 4-2: Dual Host Connection

♦ *Creating redundant host paths:* If access to data is a critical requirement, redundant data paths to different LDs or logical volumes (LVs) can be created. To do this, logical units (LDs or LVs) are mapped to both the host channels (CH0 and CH1 in *Figure 4-2*). This will ensure that if one host computer fails, the second host computer will be able to access the logical units on that host computer.

> **NOTE:** *To create dual-redundant data paths on the host side, it is necessary for third-party failover software to be installed on the host computer(s).*

♦ *Physically isolating one OS system from another:* The multiple-host configuration can also be applied when the array is shared by two or more systems. Using each host channel for a host adapter on different host computers can physically isolate one OS system from another.

This configuration is applied when two systems cannot share the same SCSI bus as the access route to storage. Unless some file system "lock manager" is available, physical drives should be configured into different logical drives or logical volumes, and each logical unit should be mapped to IDs/LUNs on each host channel. In this way, each host computer will be accessing separate logical units.

4.2.3 Expansion

The installation of an optional daughter board can expand the number of available SCSI-320 I/O channels by four. With the addition of the daughter board, the SR 170 will then have eight SCSI-320 channels available. These expansion channels are connected in the same way as described above. They can all be configured as either host or drive channels.

4.3. Controller Integration
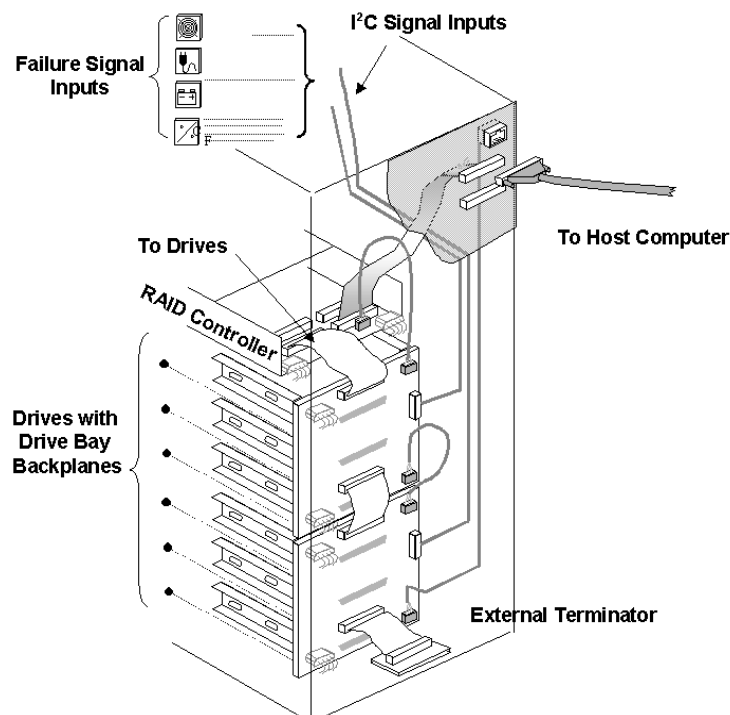
Figure 4-3: Drive Channel and Host Channel Connection

Figure 4-3 above is an example of connecting the RAID controller to the drives and the host computer. Since all channels can be configured as host or drive channels, a variety of host and drive configurations are available. The on-board terminator has been enabled on the controller side of the I/O channels. On the other end of the SCSI cable, an external terminator is applied. Termination on all SCSI drives should be disabled.

Integrators may choose a different interface for the enclosure device management. Connect remote devices (sensors for fan rotation, power supply, temperature, etc., connected through a chip) on a SCSI bus (SAF-TE) or via the I^{2}C interface as displayed in *Figure 4-3*. Controller firmware has embedded utilities to help configure these devices.

NOTE:

It is recommended to use the embedded terminators on host or drive channels by setting DIP switches, and then installing an external terminator on the other end of your SCSI cable. If a drive fails, data traffic will remain unaffected. Please note of the following:

1. *Refer to the installation documents that came with your drives for information on jumper settings.*

2. *Set a unique SCSI ID address on each drive. Avoid ID 7 – this is a default reservation for the controller. In redundant controller mode, each of the two controllers takes an ID on each SCSI bus. The combination can be ID 6 and ID 7 or ID 8 and ID 9.*

4.4. Other Connections

4.4.1 Power Connection

The power input and connection of the controller is exactly the same as those for hard disk drives.   Be sure to connect **both** connectors. The power connection is shown in ***Figure 4-4*** below.
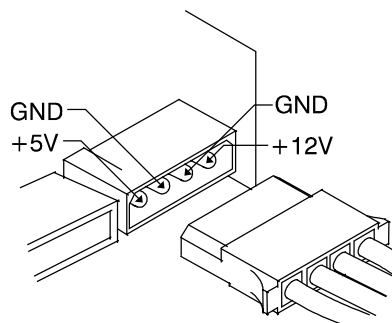
Figure 4-4: PSU Connection

4.4.2 Connecting RS-232C Terminal Emulation

The controller can be configured via a PC running a VT-100 terminal emulation program or a VT-100-compatible terminal. The provided combo cable (IFT-9512) converts the RS-232 signals from the 20-pin header into the two 9-pin D-Sub male connectors. The pin layout of the 9-pin connectors is similar to that of a PC's serial port and is set as a DTE device. Proper cable connection is displayed in the following diagram. The DB-9 connectors of the IFT-9512 cable are marked as "COM 1" and "COM 2." Please use the connector marked as "COM 1" for terminal emulation.

Connect COM 1 to the included null modem (IFT-9011) and connect the other end of the null modem to the outside of your enclosure or to an external RS-232 cable. COM ports can also connect to a modem for remote configuration. COM 2 cannot be used to download firmware.
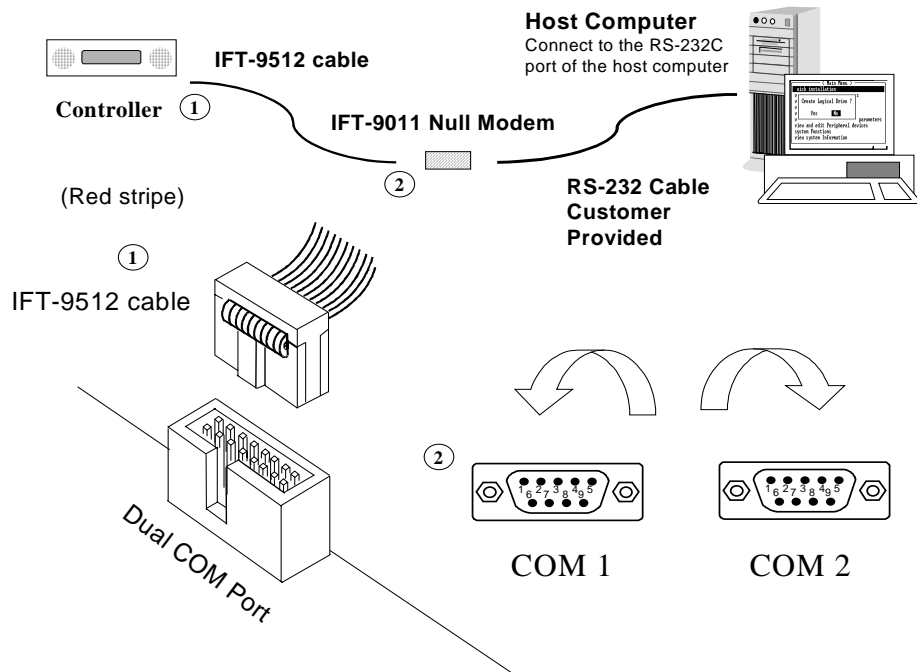
Figure 4-5: RS-232C Connection

4.5. Power On

Once all the components have been installed in the SR controller, the host channels have been connected to the host and the drive channels have been connected to the SCSI-320 drives, the controller can be powered on.

4.5.1 Check List

BEFORE powering on the SR controller, please check the following:

☐ *Memory module:* Make sure that a memory module has been correctly installed on the controller board.

☐ *BBU modules:* If installed, make sure the BBU charger board and the BBU battery pack have been installed correctly.

☐ *Host computers:* Host I/O channels have been connected to the host computers

☐ *Hard drives:* Hard drives have been connected to the drive I/O channels.

☐ *Power module connection:* The PSU connectors at the back of the controller board have been connected to an appropriate PSU.

□   *Ambient temperature:* All the controller components have been acclimated to the surrounding temperature.

4.5.2 Power On Sequence

When powering on the SR 170 controller, please follow these steps.

1. ***Power on the hard drives***

   The SCSI-320 hard drives that have been connected to the SR controller should be powered up first. For the hard drive power on procedure, please refer to the documentation that came with the hard drives.

2. ***Power on the SR controller***

   Once the hard drives have been powered on, power on the controller. To do this, turn on the power supplies that have been connected to the PSU connectors at the back of the controller board.

3. ***Power on the host computers***

   The host computers should be the last devices that are turned on. Please refer to the manual that came with your host computers to see their own power on procedures.

4.5.3 LCD Screen

When powering on the controller, the following messages should appear on the front panel LCD screen. Wait for the front panel LCD to show **READY** or **No Host LUN** before the host boots up. Refer to *Figure 4- 1* on how to read the screens.

Model Name   **Indicates Firmware version**

```
SR 170            V3.31F
Ready
```

Status/Data Transfer Indicator
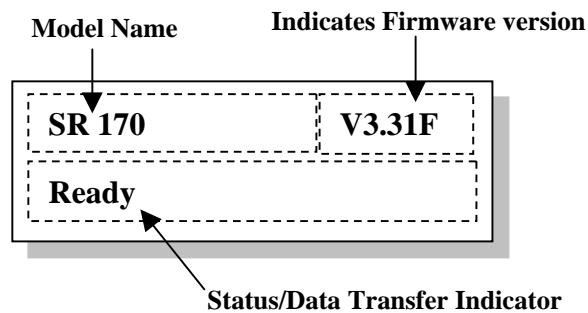
Figure 4- 1: The LCD Startup Screen

The LCD screen startup sequence is shown and described in the sequence below.
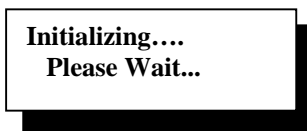
```
Initializing….
   Please Wait...
```
This screen appears when the PSUs are turned on.

```
┌─────────────────────────┐
│ SR 170        v3.31F    │
│   Modem Not Config      │
└─────────────────────────┘
```

This screen appears after the initialization process. It clearly shows the model name.

```
┌─────────────────────────┐
│ SR 170        v3.31F    │
│ 256MB RAM, Wait…        │
└─────────────────────────┘
```

```
┌─────────────────────────┐
│ SR 170        v3.31F    │
│ No Host LUN             │
└─────────────────────────┘
```

System is ready. You can now start to configure the controller.

4.6. Power Off Procedure

If you wish to power down the SR controller, please follow these steps:

NOTE:

If you wish to power down the SR controller, please ensure that no time-consuming processes, like a "logical drive parity" check or a "background scrub," are running.

---

1. ***Stop I/O access to the system***

   Use the software provided on the host computer to stop all I/O access to the SR controller. Please refer to the user manual that came with your host computer.

2. ***Disconnect the host***

   The host must be disconnected from the controller. To do this, disconnect the cables from both the host and the SR controller.

3. ***Flush the cache***

   Use the "Shutdown Controller" function to flush all cached data. This prepares the controller to be powered down.

4. ***Turn off the power***

   Turn off the PSUs that supply power to the SR controller. Once the RAID controller has been powered down, other devices that are connected to the controller may be powered down.

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Chapter 5
Controller Maintenance

5.1. Controller Maintenance Overview

5.1.1 About Controller Maintenance

Constant monitoring and maintenance of your SR 170 controller will minimize downtime and preserve the working integrity of the controller for a longer period of time. If any of the controller components fail, they must be replaced as soon as possible.

5.1.2 User Serviceable Components

Most of the controller components are user serviceable, i.e., replaceable. The following components can be replaced in case of failure:

♦   Daughter board

♦   DIMM module

♦   BBU module

♦   BBU charger board

The LCD panel and the controller board very seldom fail and it is therefore not necessary to replace them. If either of these items fails, the whole controller box needs to be replaced.

5.1.3 Controller Maintenance Considerations

♦   Qualified engineers who are familiar with the SR controller should be the only ones who perform maintenance operations on the controller. If you are not familiar with the SR controller or with RAID appliance maintenance in general, it is strongly advised that you refer SR controller maintenance to a suitably qualified maintenance engineer.

♦   When performing maintenance procedures on the controller, all safety regulations described in *Chapter 2* must be strictly adhered to. Failure to adhere to these regulations may cause permanent, irreparable damage to the controller. It should especially be remembered that the controller board and the daughter board are very sensitive components that can be easily damaged.

♦   When replacing any of the controller components, it is necessary to access the controller board in controller canister. It is recommended that all power to the controller canister is turned off when maintenance procedures are being carried out.

♦   If the DIMM module, controller board or daughter board fail, the maintenance operations must be completed as soon as possible.

♦   If either the BBU module or the BBU charger board fail, it is not necessary to perform maintenance operations immediately. Because all I/O access to the controller will be shut off for the duration of the maintenance procedure, it is recommended that you carefully select the time when maintenance operations will be carried out.

5.2. Replacing a failed DIMM Module

5.2.1 When should a DIMM module be replaced?

There are two instances when a DIMM module should be replaced:

♦   *Case 1: DIMM module fails*

If a DIMM module fails it must be replaced immediately. The controller cannot function without a DIMM module and is therefore rendered inoperable. In this instance, DIMM module replacement becomes a priority and must be replaced as soon as possible.

♦   *Case 2: DIMM module with larger capacity required*

If the capacity of the currently installed DIMM module is not sufficient, it can be replaced with a larger capacity DIMM module. In this instance, it is best to replace the DIMM module during the least busy time as the controller will have to be powered down and removed.

5.2.2 DIMM Module Replacement Procedure

Step 1. *Power off the controller*. Prior to removing the controller module, it is necessary to power off the controller.

Step 2. *Access the controller module*. The DIMM module is located on the controller board. To replace the DIMM module, remove the chassis top cover and open the chassis. The complete removal procedure is described in *Chapter* 2, *Section 2.6.2*.

Step 3. *Remove the optional daughter board*. If an optional daughter board has been installed, it must be removed. The DIMM module is located beneath the daughter board. See *Section 5.4.2* below.

Step 4. *Remove the optional BBU charger board.* The BBU charger board obstructs the DIMM module and must therefore be removed. See *Section 5.3.3* below.

Step 5. *Insert the new DIMM module*. To install the replacement DIMM module, align it with the DIMM slot. Next, gently push the new module into the DIMM socket. The white clips on either side of the DIMM socket will automatically close and lock the new DIMM module into place. (See *Figure 5-1*)

Figure 5-1: Remove the DIMM Module

Step 6. *Insert the new DIMM module*. Once the old DIMM module has been removed the replacement DIMM module can be installed. To install the replacement DIMM module align it with the DIMM slot. Next, gently push the new DIMM module into the DIMM socket. The white clips on either side of the DIMM socket will automatically close and lock the new DIMM module into place. (See *Figure 5-2*)
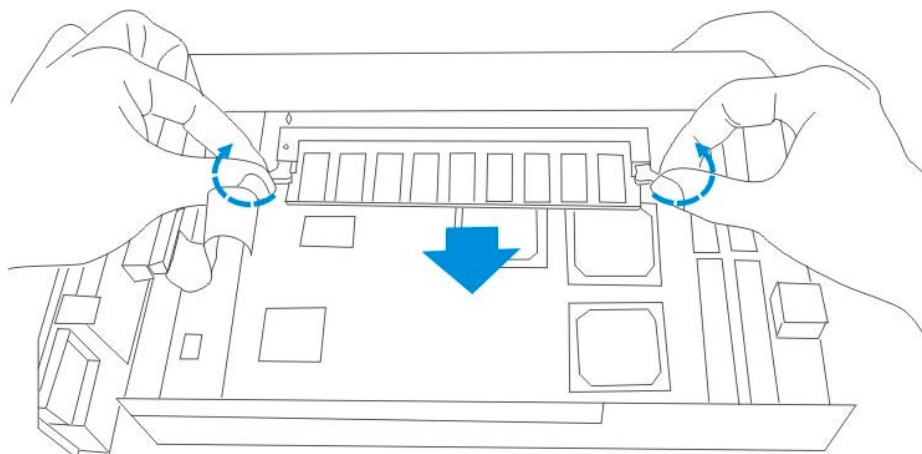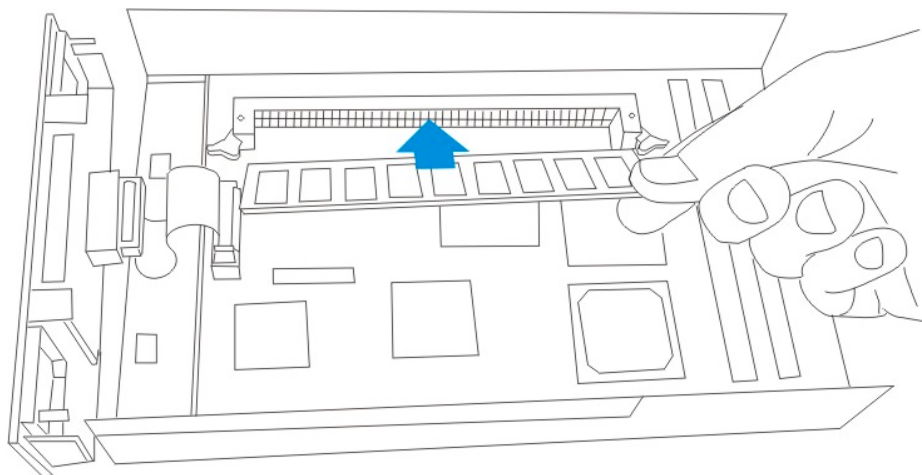

Figure 5-2: Install a DIMM Module

Step 7. *Reinstall the optional BBU charger board*. Once the new DIMM module is installed, if an optional BBU charger board was previously removed it can now be reinstalled onto the controller board. See *Section 5.3.3* below.

Step 8. *Reinstall the optional daughter board*. Once the optional BBU charger board has been reinstalled, if an optional daughter board was previously installed on the controller board, it too can be reinstalled. See *Section 5.4.2* below.

Step 9. *Replace the chassis top cover*. Once the DIMM module, optional BBU charger board and optional daughter board have all been reinstalled, the chassis top cover must be reinstalled. For detailed instructions on how to reinstall the chassis top cover, please refer to *Section 2.6.2*.

5.3. Replacing a Failed Optional BBU Module

5.3.1 About BBU Maintenance

Maintaining the BBU requires that two items be maintained:

◆ *BBU battery pack:* The BBU battery pack contains the cells that provide power to the memory cache during a power outage. The battery pack is connected to the battery charger board or the connector at the back of the controller board. It is important that the BBU battery pack is replaced every two years.

◆ *BBU charger board:* The BBU charger board is installed on the controller board. The charger board keeps the battery pack charged so that the BBU can support the cache memory during a power outage.

If either of these components fails, it will have to be replaced.

5.3.2 BBU Battery Pack Replacement

5.3.2.1 Case 1: BBU Battery Pack Connected to the Controller Board Backplane Connector

If the BBU battery pack is attached to the connector on the rear of the controller board, the cable attached to this connector must be removed and the connector on the replacement battery pack connected. (See *Figure 5-3*)
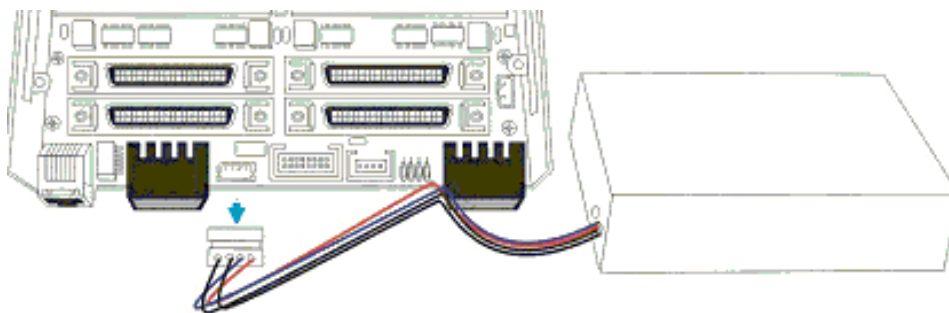
Figure 5-3: Disconnect the BBU Connector from the Connector at the Back of the Controller Board.

5.3.2.2 Case 2: BBU Battery Pack Connected to the Charger Board Connector on the Controller Board

If the BBU battery pack is attached to the connector on the BBU charger board, please follow these instructions:

Step 1. *Access the controller module.* The BBU charger board is located on the controller board. To disconnect the BBU battery pack from the charger board, remove the chassis top cover and open the chassis. The complete removal procedure is described in *Chapter 2*, *Section 2.6.2*.

Step 2. *Disconnect the BBU battery pack connector.* Once the controller board has been removed, disconnect the failed BBU pack from the charger board connector. (See *Figure 5-4*)

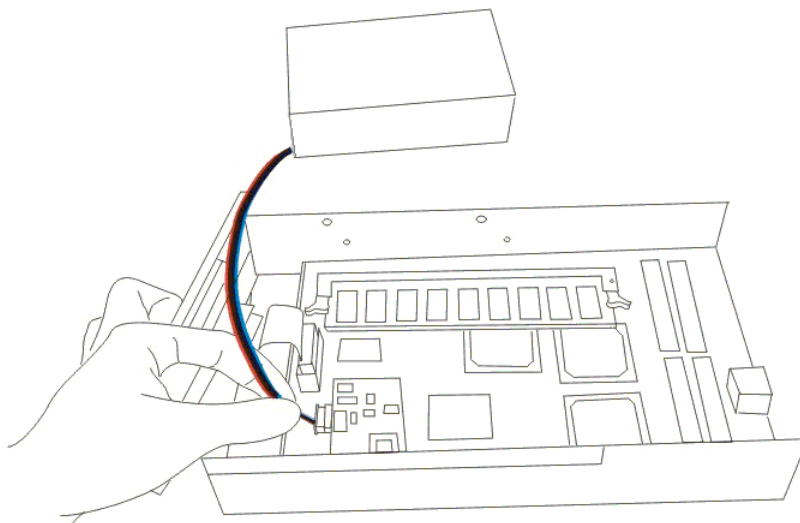**Figure 5-4: Disconnect the BBU Connector from the Charger Board**

Step 3. *Connect the new BBU battery pack.* Connect the replacement BBU battery pack to the BBU charger board.

Step 4. *Replace the chassis top cover.* Once the new BBU battery pack has been connected to the BBU charger board, the chassis top cover must be reinstalled. For further instructions on how to reinstall the chassis top cover, please refer to *Section 2.6.2*.

5.3.3 BBU Charger Board Replacement

To replace the BBU charger board, please follow these instructions:

Step 1. *Access the controller module.* The BBU charger board is located on the controller board. To replace the BBU charger board, remove the chassis top cover and open the chassis. The complete removal procedure is described in *Chapter 2*, *Section 2.6.2*.

Step 2. *Disconnect the BBU battery pack.* If the BBU battery pack has been connected to the battery charger board, it should be disconnected. See *Section 5.3.2.2* above.

Step 3. *Remove the BBU charger board*. Locate the BBU charger board and gently pull it up to remove.

Step 4. *Install the new charger board on the controller board*. Complete installation instructions are described in *Chapter 2*, *Section 2.8*.

Step 5. *Connect the BBU pack.* Connect the BBU battery pack to the charger board onboard connector. See *Section 5.3.2.2* above.

Step 6. *Replace the chassis top cover.* Once the BBU charger board has been installed and connected to the BBU battery pack, reinstall the chassis top cover. For further instructions on how to reinstall the chassis top cover, please refer to *Section 2.6.2*.

5.4. Daughter Board Maintenance

5.4.1 About Daughter Board Maintenance

The daughter board is an optional item installed on the controller board that is used to expand the number of available SCSI-320 I/O channels. A daughter board can be damaged by over heating and static electricity, among other things.

5.4.2 Replacing a Daughter Board

To replace a daughter board, please follow these steps:

Step 1. *Access the controller module*. The daughter board is located on the controller board. To replace the daughter board, remove the chassis top cover and open

the chassis. The complete removal procedure is described in *Chapter 2*, *Section 2.6.2*.

Step 2. *Remove the retention screws*. The daughter board is secured to the controller board with three retention screws that pass through spacers mounted on the controller board. Remove these three retention screws. (See *Figure 5-5*)
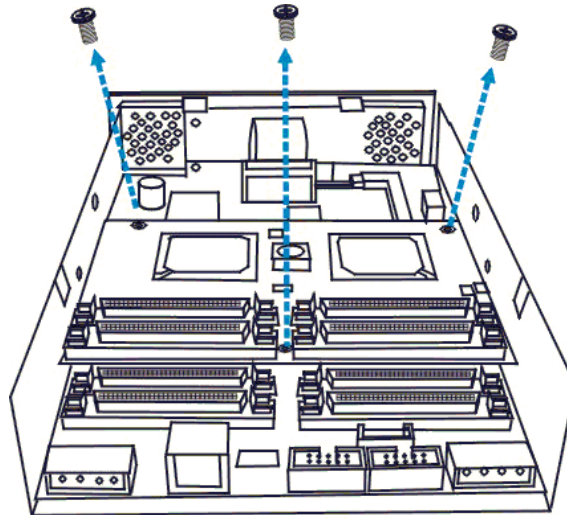
Figure 5-5: Remove the Daughter Board Retention Screws

Step 3. *Remove the daughter board.* The daughter board is connected to the controller board through two board-to-board connectors. To disconnect the failed daughter board from the controller board, gently lift it up.

Step 4. *Install the new daughter board.* Correctly align the board-to-board connectors on the daughter board with those on the controller. Place the daughter board onto the controller board and push down gently, ensuring that the board-to-board connectors are properly connected. Use the previously removed retention screws to secure the daughter board to the controller board.

Step 5. *Replace the chassis top cover.* Once the new daughter board has been properly installed, reinstall the chassis top cover. For further instructions on how to reinstall the chassis top cover, please refer to *Section 2.6.2*.

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Appendix A
SentinelRAID Features

A.1. Overview

The SR controller comes with many different features. Some of these features enhance the performance of the controller or add configuration flexibility while other features simplify the installation, maintenance procedures of the controller. This section highlights some of the features of the SR controller.

A.2. Controller Features

A.2.1 SCSI-320 I/O Channels

All of the I/O channels on both the controller board and the daughter board are SCSI-320 compatible. These channels can be connected to SCSI-320 host computers and SCSI-320 drives with data transmission rates of up to 320MB/second.

A.2.2 Flexible Configuration

All of the SCSI-320 I/O channels can be configured as host or drive channels. Eight logical drives can be created from physical drives and eight logical volumes can be created from one or several logical drives. You may then divide storage capacity by partitioning each of the logical units into eight portions for a total of 64 partitions. Various RAID levels can be applied to different logical units with the support of dedicated or global spare drives.

A.2.3 Expansion

Channel expansion: With the installation of an optional daughter board, the SR 170 controller can support up to eight SCSI-320 channels.

Capacity expansion: Logical drive capacity can be expanded either by adding a new drive or copying and then replacing the original members with drives of larger capacity.

A.2.4 User-friendly Configuration Utilities

There are multiple choices of interfaces or management programs for configuring the RAID system. Administrators may choose one or more from the LCD front panel, firmware-embedded configuration utility, and the Java-based GUI RAIDWatch Manager for local or remote management.

A.2.5 Controller Architecture

The controller is developed from Infortrend's PowerPC-500133 ASIC architecture, a third-generation, 64-bit controller design that efficiently eliminates internal bottlenecks. The controller's high performance derives from a state-of-the–art PowerPC® 750CXe RISC microprocessor, which provides a 64-bit 133MHz path to SDRAM. The 500133 integrates SDRAM control, CPU peripheral, dual 64-bit PCI buses, and hardware XOR functions. The ASIC provides 133MHz operating frequency for CPU and DRAM interfaces, and 66MHz for PCI interfaces. Two 64-bit 66MHz PCI buses can operate independently to maximize the performance.

A.3. Fault Tolerance

A.3.1 Global and Local Spares

Both global and local (dedicated) spares are supported. The controller(s) will automatically disconnect from a failed drive and start to rebuild data on the spare drive. The spare drive will then replace the failed drive.

A.3.2 Hot-swapping of Drives

A failed drive can be exchanged without turning off the system or interrupting its smooth operation. Once the failed drive is replaced, the data will be rebuilt in the background. Hot-swapping is supported through the automatic disconnection from a failed drive and the detection of a reserve drive. All of these failure recovery procedures are completely transparent to the host.

A.3.3 S.M.A.R.T. Support

S.M.A.R.T (Self Monitoring Analysis and Reporting Technology) is supported with configurable reaction schemes. You may select different reaction schemes for immediate prevention against S.M.A.R.T.-detected errors. Available options include: detect only, clone and replace, and perpetual clone. A faulty drive can be cloned to an active spare upon the discovery of errors.

A.3.4 Other Fault Tolerant Features

Other comprehensive failure management features on the SR controller include:

- Automatic bad-block assignment

- Background rebuilding

- Verify-after-write support on normal writes, rebuild writes, and/or RAID initialization writes

- Regeneration of parity of logical drives in the background

A.4. Functional Features

A.4.1 RAID Levels Supported

The following RAID levels are supported: RAID 0, 1(0+1), 3, 5, 10, 30, 50, NRAID and JBOD.

A.4.2 Controller Chassis

The 5.25-inch profile of the controller chassis allows it to be easily integrated into an external subsystem enclosure or directly into a host systems drive bay.

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Appendix B
Hardware Specifications

B.1. Configuration

Specification	Feature
RAID Levels	0, 1(0+1), 3, 5, 10, 30, 50, JBOD, and non-RAID disk spanning
Host O/S Compatibility	Host O/S independent
SCSI Channels	4 on base module 8 (with the expansion daughterboard)
Host Interface	SCSI-320
Host Channels	All channels can be configured as host or drive channels
Drive Interface	SCSI-320
Drive Channels	Up to 3; up to 7 with the expansion daughter board
Maximum Number of SCSI Drives	Up to 105 (on 7 drive channels)
Cache Memory Size	At least 128MB, supports up to 1GB; PC-133 SDRAM DIMM socket x1 with ECC support
Cache Mode	Write-through or write-back
Logical Drives	Up to 8
Partitions	Up to 8 per logical drive or logical volume, 64 total
Number of LUNs	Up to 32 per SCSI ID, 128 per controller
Multiple SCSI IDs per Host Channel	Yes
Firmware on Flash Memory	Yes; main RAIDWatch agents included
Drive Hot Swapping	Yes

Table B-1: Controller Configuration

B.2. Controller Architecture

Specification	Feature
CPU	PowerPC® 750CXe 600MHz microprocessor
SCSI Controllers	LSI 53C1030T SCSI controller
DIMM Slot	One 168-pin DIMM module
PC-133 Support	Yes
ASIC	Infortrend 64-bit chipset
Flash ROM	2MB
NVRAM	32KB
Hardware XOR	Yes
Channel Termination	On-board LVD active termination, configurable via backplane DIP switch
I/O Channel Bandwidth	SCSI-320,: up to 320Mbytes/second
Real-time Clock	For event messages with time record

Table B-2: Controller Architecture

B.3. RAID Management

Specification	Feature
Performance Monitoring	Yes
Remote Control and Monitoring	Yes
Event Broadcast/Alert	Yes (via Java-based RAIDWatch Manager and Event Monitor)
Event Notification	Yes (via RAIDWatch's sub-module NPC)
Hardware Connection	In-band over SCSI or Fibre, Ethernet, or RS-232C
Configuration on Disk	Configuration data stored on disks for logical drive assemblies to exist after controller replacement
Failure Indicator	Via alarm, LCD panel, RAIDWatch Manager, or terminal emulation

Table B-3: RAID Management

B.4. Fault Tolerance

Specification	Feature
Drive S.M.A.R.T. Support	Yes (with user-configurable detect only, clone and replace, and perpetual clone functions)
Battery Back-up Option	Yes
SAF-TE Support	Yes
S.E.S. Support	Yes
ISEMS (Infortrend Simple Enclosure Management Service) via I^2C Interface	Yes
Automatic Drive Failure Detection	Yes
Automatic Rebuild on Spare Drives	Yes
Regenerate Logical Drive Parity	Yes
Bad Block Reassignment	Yes
Automatic Rebuild upon Failed Drive Replacement	Yes
Manual Clone of Suspected Failed Drive	Yes
Concurrent Rebuild on Multiple Drives in a RAID (0+1) Logical Drive	Yes
Salvage the Second Temporary Failed Drive in a RAID 1, 3 or 5 Logical Drive	Yes
Salvage the First Temporary Failed Drive in a RAID 0 Logical Drive	Yes
Variable Stripe Size	Optimization for sequential:128KB Optimization for random: 32KB

Table B-4: Fault Tolerance

B.5. Software

Specification	Feature
In-band Text RAID Manager	Yes (all major platforms)
RAIDWatch Manager	Yes (for any platform that supports Java 2.0 or for Java Applet running via web browser)
LAN/WAN Support via SNMP	Yes

Table B-5: Available Software

B.6. Technical Specifications

B.6.1 Physical Dimensions

Specification	Size
Controller Size in Frame	10.39 x 5.74 x 1.60 (L x W x H) inches
Main Board Height with Daughterboard	1.30-inch

Table B-6: Controller Physical Dimensions

B.6.2 Environmental Specifications

Description	Specification
Operating Temperature	4 - 44°C
Operating Ambient Temperature within Enclosure	< 50°C
Relative Humidity	10 - 95%, non-condensing
Operating Altitude	Sea level - 10,000 ft
MTBF	> 500,000 hours

Table B-7: Environmental Specifications

B.6.3 Controller Specifications

Description	Specification
Cache memory	At least 128MB, up to 1GB, PC-133 SDRAM DIMM socket x1
Firmware	Resides in 2MB Flash memory
NVRAM	32KB
Devices per Channel	SCSI: up to 15 SCSI devices
Supported Device Types	Synchronous or asynchronous
RAID Levels Supported	0, 1(0+1), 3, 5, 10, 30, 50, JBOD and non-RAID disk spanning
SCSI Connectors	68-pin high-density connectors (x 4) on base module
SCSI Cables	Up to 12 meters with low-voltage differential
Serial Port	20-pin box header for COM1 & COM2
Ethernet Port	10/100M
LCD Panel	Yes
LED and Push-button Interface	Yes
Board Connectors	160-pin male docking connectors (x 2) on main board (I-PEX model number T80043-160T); connects main board to main board backplane, integrating SCSI/Fibre channels, redundant controller features, RS-232C COM-1 and COM-2, battery connector signal, on-board alarm, external LCD module, SAF-TE status inputs, Ethernet port, I^2C port and drive failure indication interface

Table B-8: Controller Specifications

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Appendix C
Hardware Troubleshooting

C.1. Problem

♦ **LCD is off**

1. Check the power connection on the controller board and LCD panel.
2. Check that a minimum of 128MB SDRAM DIMM is installed.

♦ **7-segment LED flashes "F"**

1. The DIMM module is not installed yet.
2. The socket plug (loop-back circuits board) for the battery charger connector (JP8) is not installed.

Problem	Solution
7-segment LED flashes "F"	1. DIMM module not installed yet. 2. Socket plug (loop-back circuits board) for battery charger connector (JP8) not installed.

SCSI channel failure detected upon start-up (SCSI cables connected)
 Message on LCD:
 	
 `SCSI CHLs fail`
 `CHL=x,x,x`
	1. Check cable connection
	 2. Check ID numbers (must be unique for each device on the same SCSI channel).
	 3. Make sure that SCSI channels are properly terminated.
	 4. Check the voltage output of the power supply.
	 5. Connect both power connectors

Initialization failure	1. Check ID numbers (must be unique for each device on the same SCSI channel). 2. Make sure terminators are properly installed.
Cannot detect SCSI drive	1. Check drive power connection. 2. Check drive SCSI cable connection. 3. Check ID numbers (must be unique for each device on the same SCSI channel).
Host can not detect the controller	1. Check host-side SCSI cable connection. 2. Check SCSI port to LUN assignment. 3. Check logical drive's mapping to LUN. 4. If there is no logical unit created, the controller must be set as a peripheral device.

Parity error detected	SDRAM DIMM should be replaced.
Logical drive failure detected during boot-up	Check proper installation or connection of drives (use the "View and Edit SCSI drives" function to help locating the problem).
System is not stable after running for a period of time.	1. SCSI cable length must be within the range of specifications. 2. Make sure terminators are properly installed. 3. Power supply voltage must be within specifications. 4. Check the enclosure's inner temperature.
When using "Scan New SCSI Drive" and the desired ID is empty, an empty drive entry appears	Remove the empty drive entry
The RS-232C Terminal Interface does not work.	1. Check RS-232C cable connection. 2. Check if the Baud Rate settings on both ends identical. 3. Enable Terminal Emulation. 4. Set "Data Routing Direct to Port" in the " Communication Parameters."
When choosing "Configure Modem Port", the screen is full of " Comm Buffer Overflow".	"Terminal Emulation" should be enabled after all modem configurations are completed.
The logical drive states "INVALID".	1. "Optimization for ... I/O," the logical drive caching parameter is different from the current setting. 2. Change "Optimization for ...I/O" to the opposite setting and reset the controller.
In "View and Edit SCSI Drives" or "View and Edit SCSI Channels", the speed is only "80Mhz" (SCSI-320 machines), not "320Mhz"	"80Mhz" is SCSI sync frequency, not transfer rate.

All settings are too complex to remember.	1. After system installation is complete, write down all the settings and related information using Chapter 11 of your "Generic Operation Manual" for future reference. You may also save your configuration data as a retrievable file (using TextRAID manager) or save it to disks. 2. Save NVRAM to a file or to drives
Upon replacing the failed controller with a new one during redundant controller connection, nothing appears on the LCD of the new controller.	1. Set the new controller as "redundant controller enabled" before connecting to the active controller. 2. Connect the new controller to the active controller and choose "Deassert failed controller" on the active controller. 3. Refer to "Chapter 12, Redundant Controller of your Generic manual" for more detail.
`Error: Check` `DRAM Installed?`	Check to see if a DIMM module is installed or properly installed. Reinstall a DIMM module will usually solve the problem.
`SR 170   v3.**` `No Host LUN`	This is a normal message if no logical drive has been created or no logical drive has been mapped to a host channel ID/LUN.
`SR 170   v3.**` `Ready`	This is a normal message when a logical drive has been created and mapped to a host channel ID/LUN.
`[Other error` ` messages]`	Please contact your system vendor for assistance with any other error messages. You may also refer to Appendix D of your "Generic Operation Manual" to learn more about error messages.

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Appendix D
Spare Parts and Accessories

D.1. Spare Parts

The following table lists the available spare parts for the SR 1700/2700 external controllers.

Spare Part	Part Number	Description
Daughter Board	IFT- 9284U4A	Expansion board with four additional SCSI-320 interfaces

Table D-1: SR 170 Spare Parts

D.2. Accessories

The following table lists the available accessories for the SR 1700/2700 external controllers.

Accessory	Part Number	Description
Battery Charger	IFT-9070D	Mounted on the controller board; charges the BBU
Battery Module	IFT-9010D	Supports a memory cache for up to 72 hours during a power failure
Battery Expansion Cable	IFT-9519D	Connects the controller to a battery
Null Modem	9011	Facilitates serial connection between the controller and terminal computer
Bezel Key	9531	Used for the removal of the front panel
COM 1/2 Combo Cable	9512	Serial port cable
Ethernet Cable	9537	Connects the controller to the internet for online controller management

Table D-2: SR 170 Accessories

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Appendix E
Connectors and Jumper Identification
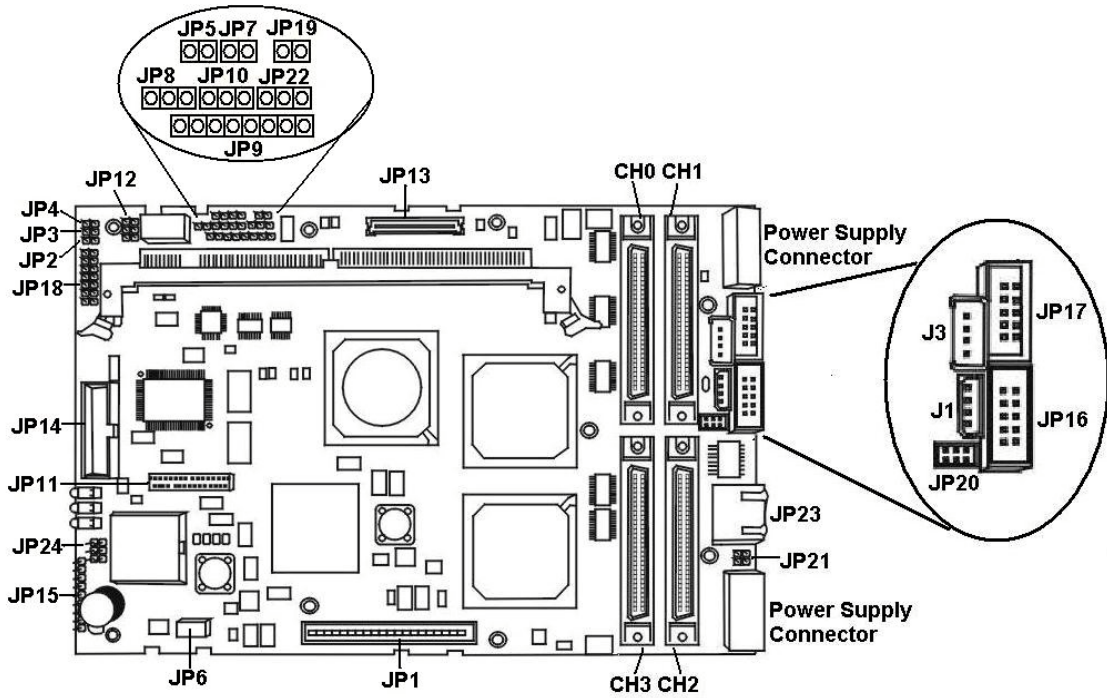
E.1. Controller Main Board Interfaces

Figure E-1: Jumper Locations

E.2. Controller Main Board Interface Descriptions

Label	Connector Name
JP1 and **JP13**	Daughter board connectors
JP6 and **JP11**	Battery charger board connector
JP2, JP3, and JP4	LED connectors
JP5	Not Mask Interrupted (NMI)
JP7	Reset
JP8	Loop-back test
JP9	GAL
JP10	LCD type selection
JP14	LCD connector
JP19	Restore firmware default
JP22	Front panel fan status detect
CH0, CH1, CH2 and **CH3**	SCSI-320 connectors
J3	I^2C connector
J1	Battery connector
JP16 and **JP17**	COM1 and COM2 connector
JP20	SCSI terminators
JP23	RJ-45 Ethernet connector

E.3. LED Jumper Pin Outs

E.3.1 JP 2 LED

Pin	Description	Pin	Description
1	Partner Failed	2	GND

E.3.2 JP 3 LED

Pin	Description	Pin	Description
1	Ready	2	GND

E.3.3 JP 4 LED

Pin	Description	Pin	Description
1	Not Ready	2	GND

E.4. COM Port Pin Outs

E.4.1 JP 16 RS-232C Port

Pin	Description	Pin	Description
1	DCD1	6	DSR1
2	RXD1	7	RST1
3	TXD1	8	CTS1
4	DTR1	9	RT1
5	GND	10	N/C

E.4.2 JP 17 RS-232C Port

Pin	Description	Pin	Description
1	DCD2	6	DSR2
2	RXD2	7	RTS2
3	TXD2	8	CTS2
4	DTR2	9	RS232 RESET
5	GND	10	N/C

E.5. J3 I^{2}C Port

E.5.1 I^{2}C Port Pin Outs

Pin	Pin Name
1	I^{2}CCLK
2	GND
3	VCC
4	I^{2}CDATA

E.5.2 I^{2}C Connector Pin Name Descriptions

Symbol	Type	Description
GND	G	Signal ground
I2CCLK	O	I^{2}C clock
I2CDATA	O	I^{2}C data
VCC	P	+5V voltage input

E.6. J1 Battery Connector

Pin	Pin Name
1	VB (battery voltage +)
2	BAT-THM (battery temperature)
3	VBATTL (battery voltage -)
4	VBATTL (battery voltage -)

E.7. TTL Device Parameters

Symbol	Parameter	Rating	Unit
V_{IN}	Input voltage	-0.5 to +7.0	V
I_{IN}	Input current	-30 to +5	mA
V_{OUT}	Voltage applied to output in high output state	-0.5 to + V_{CC}	V
I_{OUT}	Current applied to output in low output state	40	mA

Standard RS-232C cable, customer provided

IFT-9016

IFT-9011

RS-232

Controller COM Port

Swap pin 2-3; 4-6; 7-8

Standard PC Serial COM Port
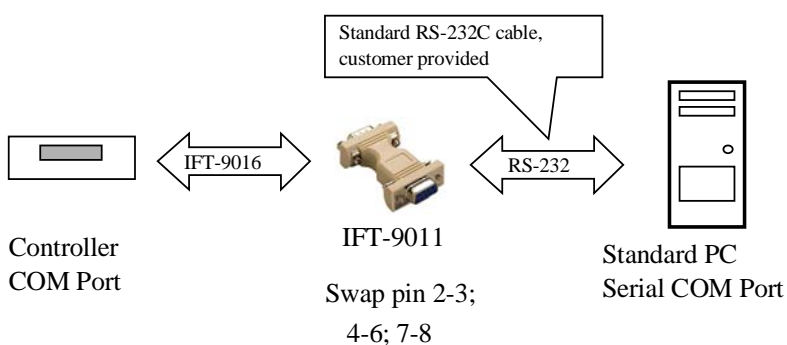
E.8. IFT- 9011 Null Modem

Swap pin-2 and pin-3
Swap pin-4 and pin-6
Swap pin-7 and pin-8

E.9. IFT-9012 RS-232C Extension Cable

(Not included in kit)

Extend the cable length only, no wire swap

--A--

accessory box, 1-7
audible alarm, 1-11, 3-1, 3-3
automatic bad block assignment, A-2

--B--

background rebuilding, A-2
base channels, 1-4
battery charger board, 1-8, 2-6
battery connector, 1-2, 1-5
battery packs, 1-8, 5-4
BBU charger board, 4-7, 5-1, 5-2, 5-4, 5-6
BBU module, 1-2, 1-8, 2-3, 2-4, 2-6, 4-7, 5-1, 5-2
buffered data, 1-8

--C--

cable specifications
cache memory, 1-8
capacitance, 4-1
capacity expansion, A-1
channel expansion, A-1
Check List, 4-7
COM ports, 1-1
COM1, 3-1
component check, 2-1
configuration flexibility, A-1
configuration utility, A-1
connection and setup, 4-6
controller architecture, A-2
controller board components, 1-10
controller board, 1-1, 1-2, 1-3, 1-5, 2-4, 2-5, 5-1, 5-2, A-1
controller box, 1-2, 2-4
controller chassis, 1-2, 1-5, 2-4
controller cooling, 1-10
CPU, 1-1, 1-10

--D--

data transmission rate, A-1
daughter board, 1-2, 1-9, 2-2, 2-3, 2-4, 2-9, 5-1, 5-2, 5-6, A-1
DC resistance, 4-1
delay skew, 4-1

DIMM module, 2-3, 2-5, 5-1, 5-2
downtime, 5-1
drive channels, 1-1, 1-4, 2-2, 2-3, 4-1, 4-2, 4-7, A-1
drives, A-1
dual host, 4-4

--E--

ECC support, 2-5
electrostatic discharge, 2-1
embedded terminators, 4-6
environmental considerations, 1-9
ESD, 2-2
expansion channels, 1-4
extension cable, 1-8
external hosts, 1-1
external interfaces, 1-1, 1-5

--F--

face plate, 4-7
failed drive, A-2
failover software, 4-4
fault tolerant, 1-1
features, A-1
firmware, 1-1, 1-10, 3-1

--G--

Generic Operation Manual, 3-3
global spare, A-2
GUI, 1-10

--H--

hard drives, 1-1, 2-1, 2-3, 4-7
high availability, 1-1
high performance, 1-1
host channels, 1-1, 1-4, 2-2, 2-3, 4-1, 4-4, 4-7, A-1
host, 2-3, 4-1, 4-8, A-1
hot-swapping drives, A-2

--I--

I/O channel connectors, 1-5
I/O channels, 1-1, 1-4, 1-9, 1-10, 2-2, 2-3, 2-9, A-1
I/O path configurations, 2-2

storage devices, 1-2
surface temperature, 2-6

--T--

temperature threshold, 3-1
terminal emulation program, 1-10, 4-6
terminator, 4-5
top cover, 2-4

--U--

unique ID, 4-2
Unpacking List, 2-1, 2-3

unpacking, 2-1, 2-3
user serviceable, 5-1

--V--

ventilation, 2-1
verify-after-write, A-2
VHDCI SCSI connector, 1-1

--W--

working integrity, 5-1
working surface, 2-2

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